

Gen 5 fixed frequency flyback controller, Gen 5 quasi-resonant flyback controller - CoolSET™, CoolMOS™, CoolGaN and CoolSiC

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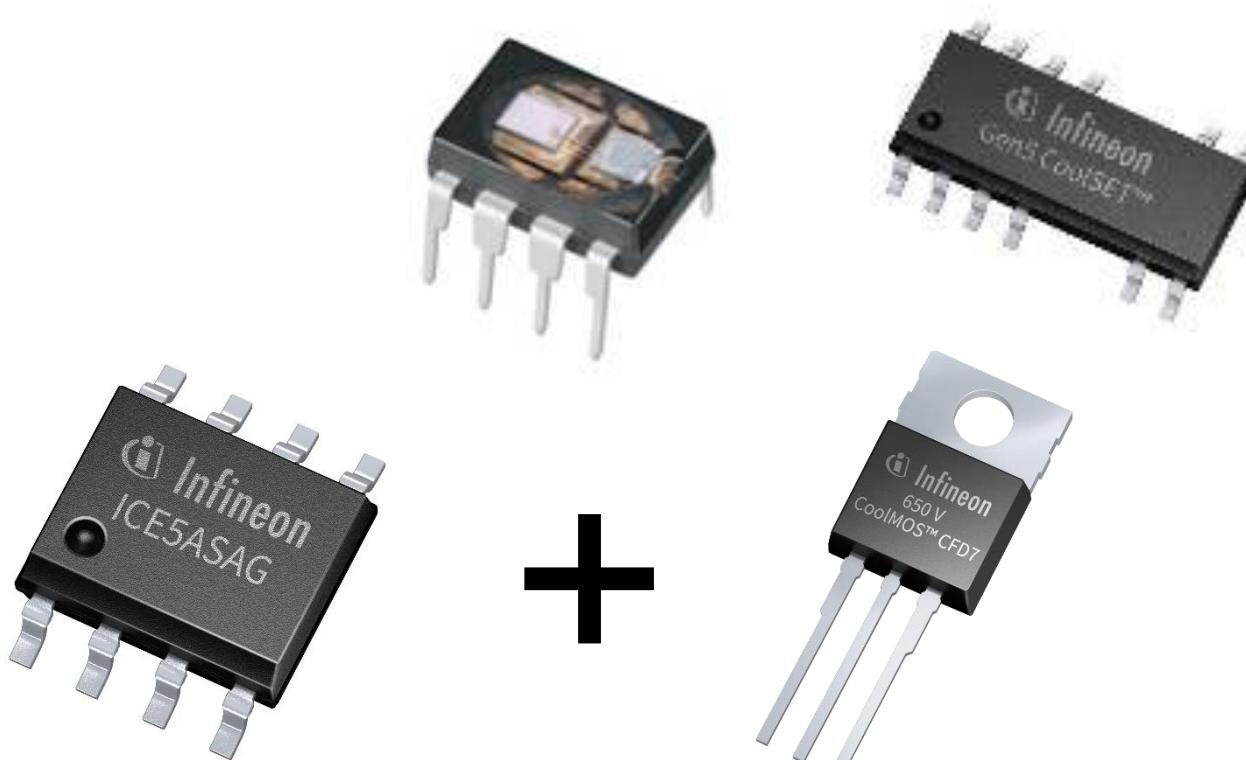


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What is CoolSET?

- › An integrated device with a PWM controller and high voltage MOSFET in a single package
- › To perform AC to DC power conversion – **S**witched **M**ode **P**ower **S**upply (SMPS)



PWM controller

High voltage MOSFET

5th generation CoolSET™ for auxiliary SMPS

Robustness

- › Integrated 700 V, 800 V or 950 V superjunction MOSFET
- › Comprehensive protection features
- › Auto-restart scheme to minimize interruption

Ease of design

- › Numerous design examples covering both indoor and outdoor aircon
- › Design tools, guide and application note
- › Reference designs

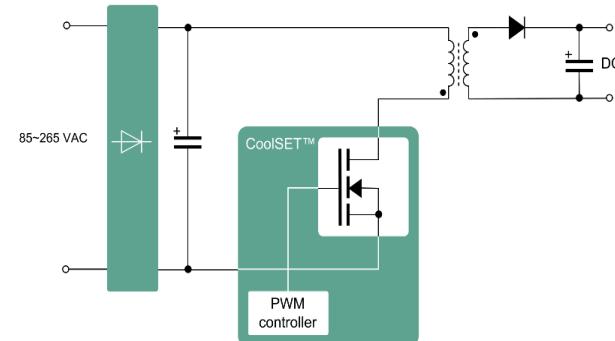
Broad portfolio

- › Choice of fixed- frequency or quasi-resonant switching scheme
- › Isolated flyback or non-isolated buck topology
- › Highest power delivery up to 43 W
- › Available in DIP-7 or SMD DSO-12 package

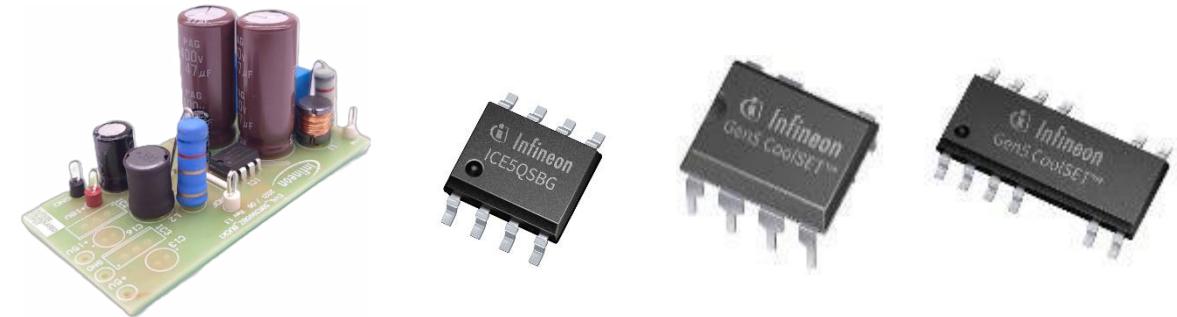
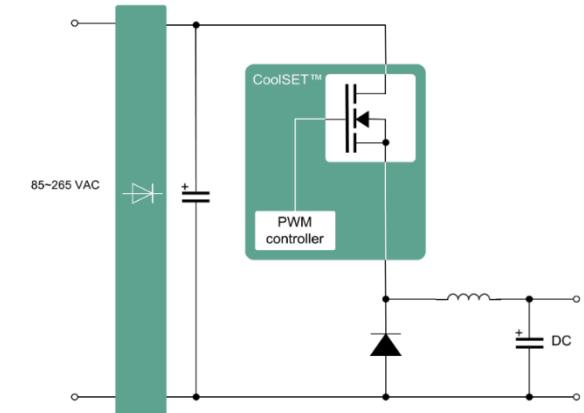


Auxiliary SMPS in Flyback or buck topology to perform AC/DC power conversion to power the various system blocks in home appliances.

Flyback

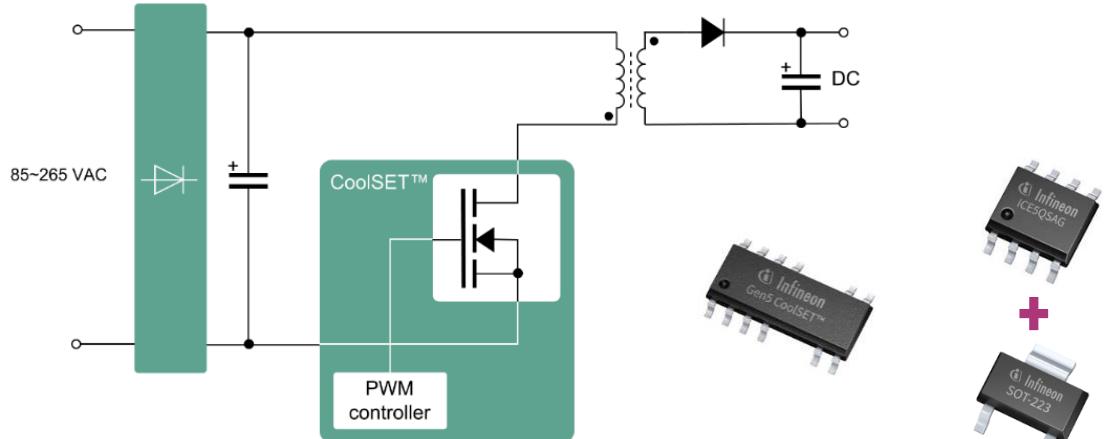


Buck

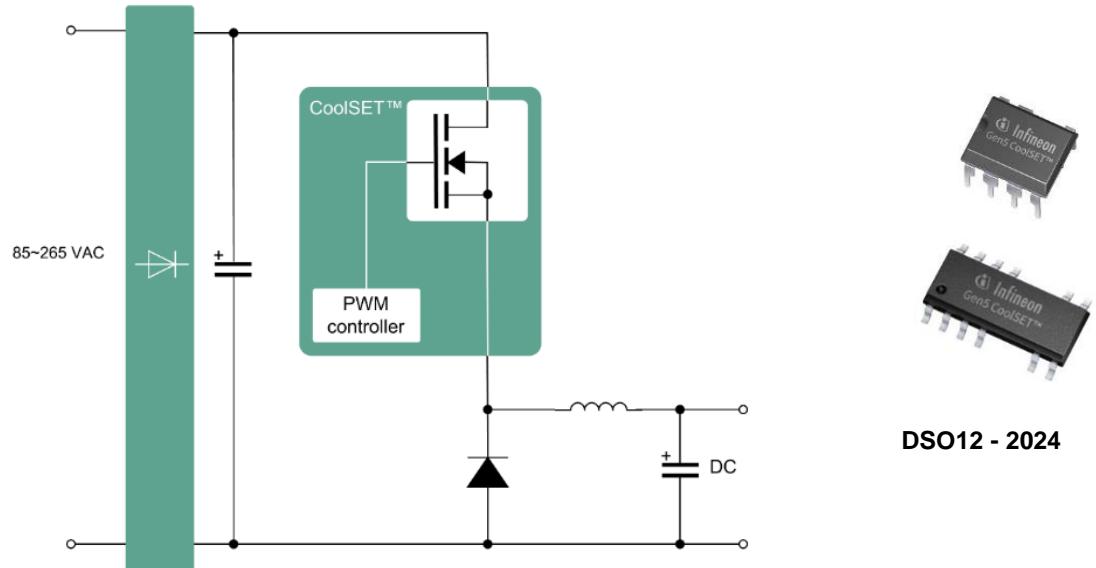


Scalable Platform – From a Few Watts to >60W

High power delivery capability in DIP-7 and DSO-12 package

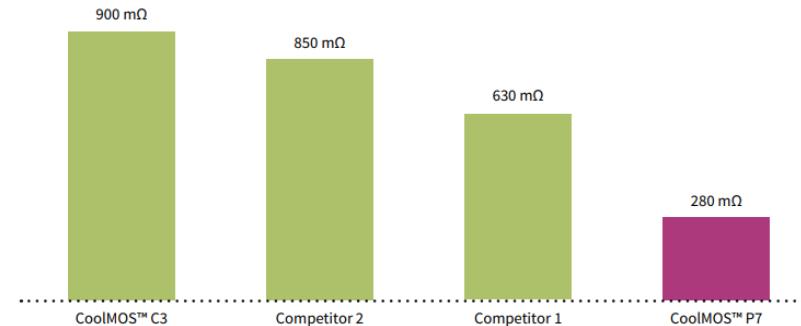


- › Offline switch mode power supply
- › Isolated and non-isolated Flyback topology
- › Output power up to 42 W - Integrated
- › >60 W with external MOSFET
- › Support an output current of up to **700 mA in Buck**
- › Robust **avalanche rugged CoolMOS™** inside



DSO12 - 2024

Overview of lowest DPAK $R_{DS(on)}$ for 800 V superjunction MOSFETs



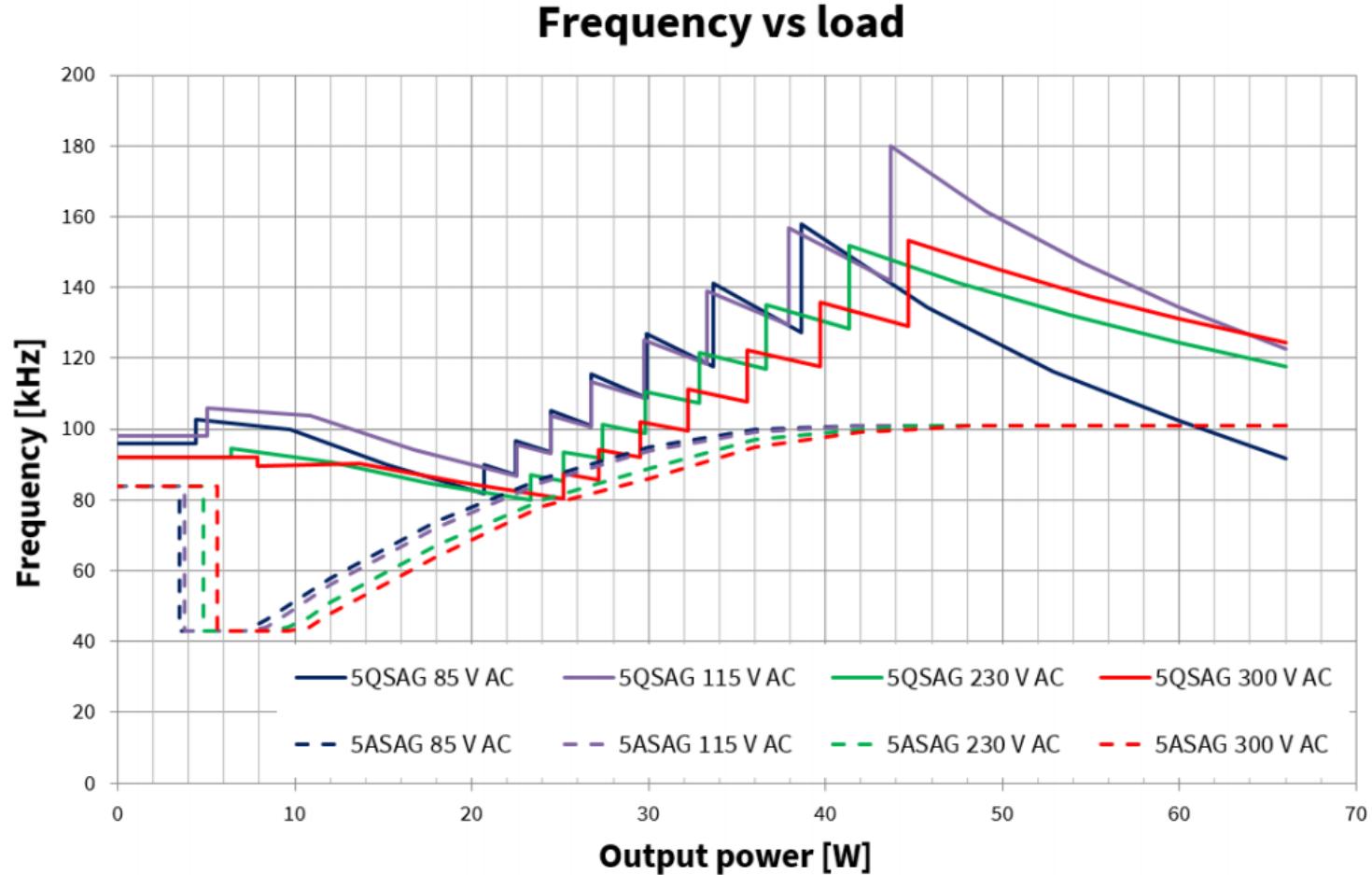
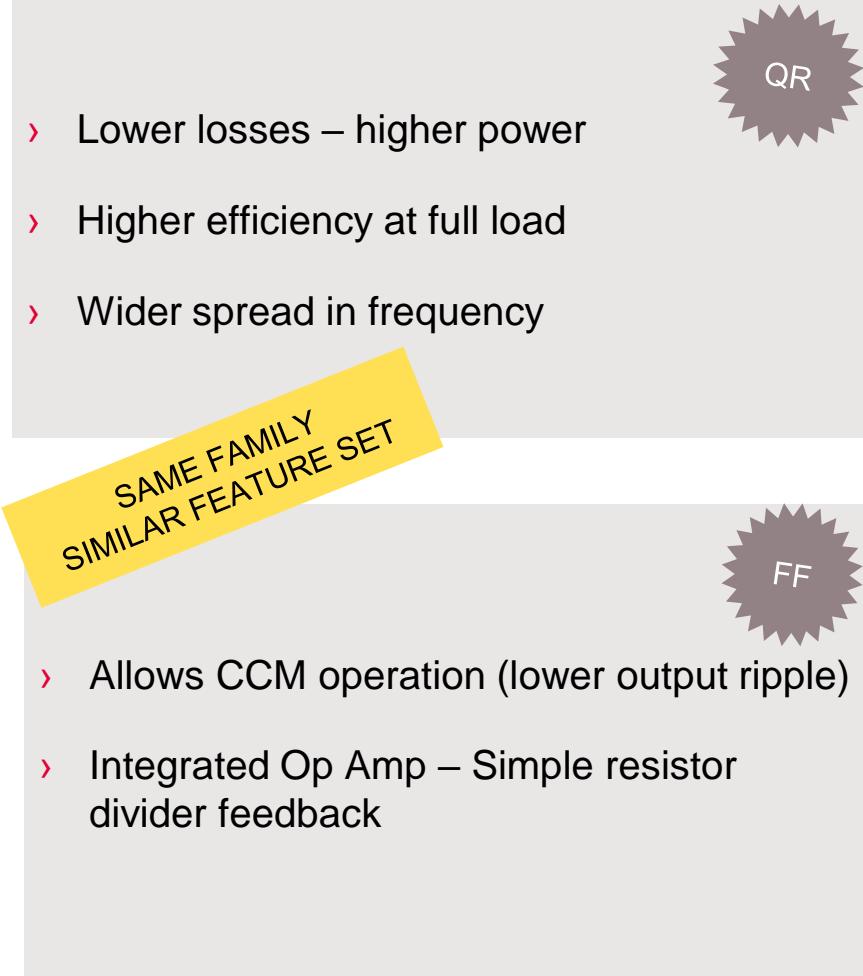
800 V CoolMOS™ P7 sets benchmark in best-in-class DPAK $R_{DS(on)}$



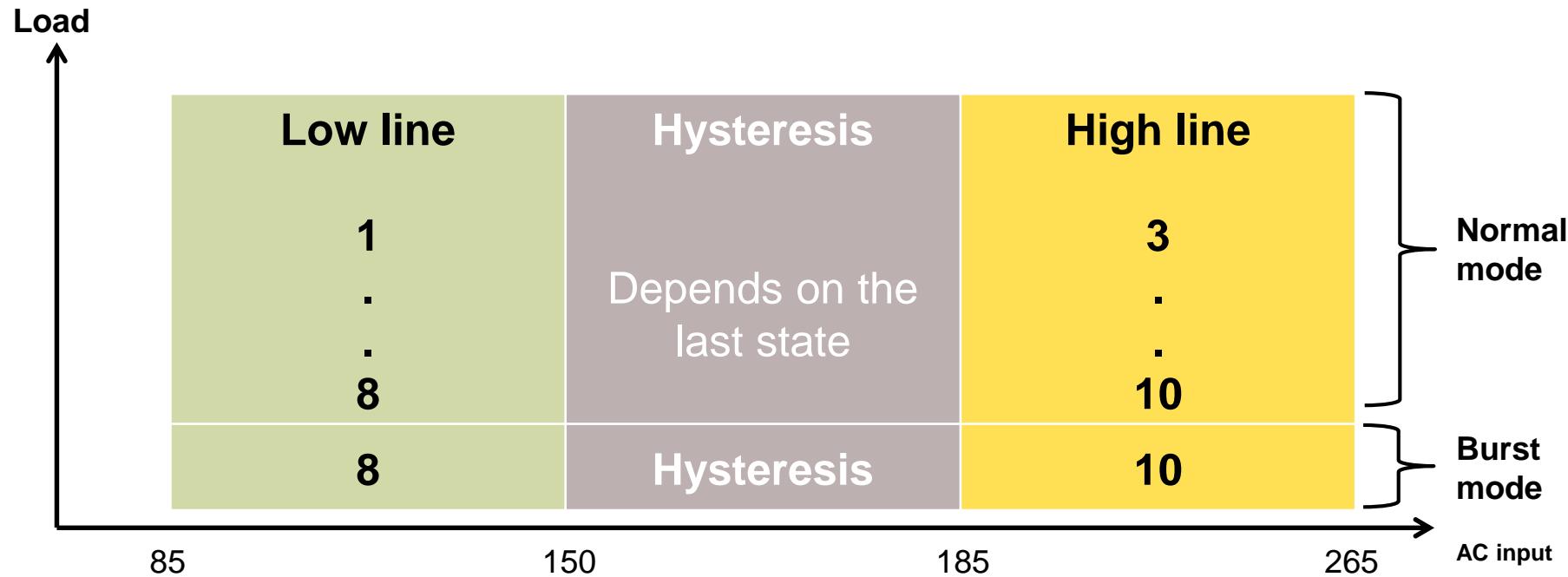
CoolSET™ Switching Scheme

	Quasi-resonant	Fixed frequency
MOSFET turn ON	<p>Diagrams illustrating the quasi-resonant switching scheme during MOSFET turn-on. The top plot shows the drain-to-source voltage (V_{ds}) and the primary current (i_{pri}). The bottom plot shows the input voltage (V_{in}) and the reflected voltage ($V_{in} - V_{reflect}$). The reflected voltage is shown as a dashed line.</p>	<p>Diagrams illustrating the fixed frequency switching scheme during MOSFET turn-on. The top plot shows the drain-to-source voltage (V_{ds}) and the primary current (i_{pri}). The bottom plot shows the input voltage (V_{in}) and the reflected voltage ($V_{in} + V_{reflect}$). The reflected voltage is shown as a dashed line.</p>
Frequency	Selectable (based on inductance value)	Fixed frequency @ 65 kHz, 100 kHz or 125 kHz
Operation	QRM	DCM or CCM
Valley Detection	Digital frequency reduction up to 10th valley	Not applicable

Gen 5 fixed frequency flyback controller versus Gen 5 quasi-resonant flyback controller - CoolSET™



Novel Quasi-Resonant (Patented)

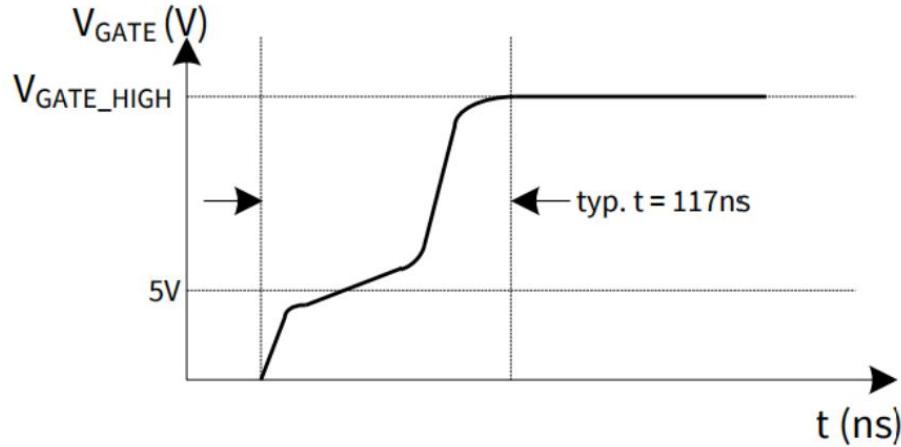


- Using the V_{IN} pin, the controller is able to differentiate between high/low AC line input to set the boundary of ZC counter operation $\rightarrow V_{VIN_REF}$
- For low line, the zero crossing counter is allow to work within 1~8 count
- For high line, the zero crossing counter is allow to work within 3~10 count
- The hysteresis region is determine by RI1 and RI2 settings



Goal: To increase efficiency @ high line and reduce switching frequency spread between high/low line

Modulate Gate Drive and Propagation Delay function



- › The drive-stage is optimized for EMI
- › The switch-on speed slows down before it reaches the CoolMOS™ turn on threshold.
- › The leading switch spike during turn-on is minimized

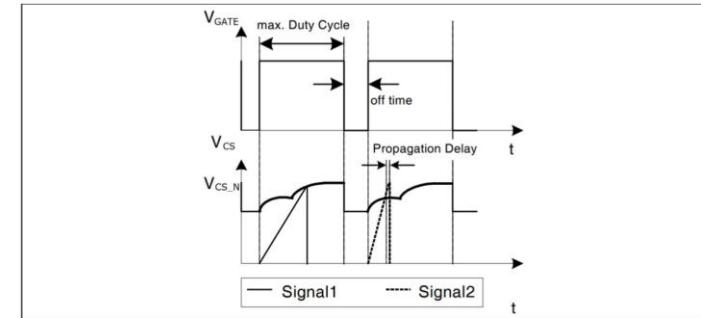


Figure 11 Dynamic voltage threshold $V_{CS,N}$

Functional description

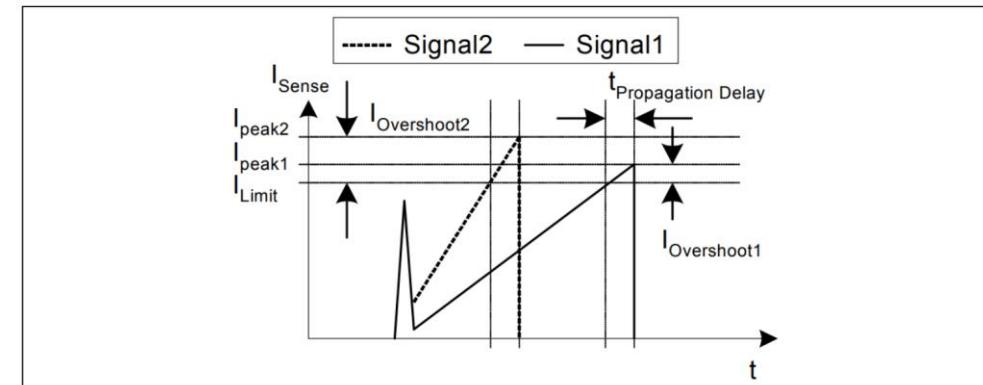
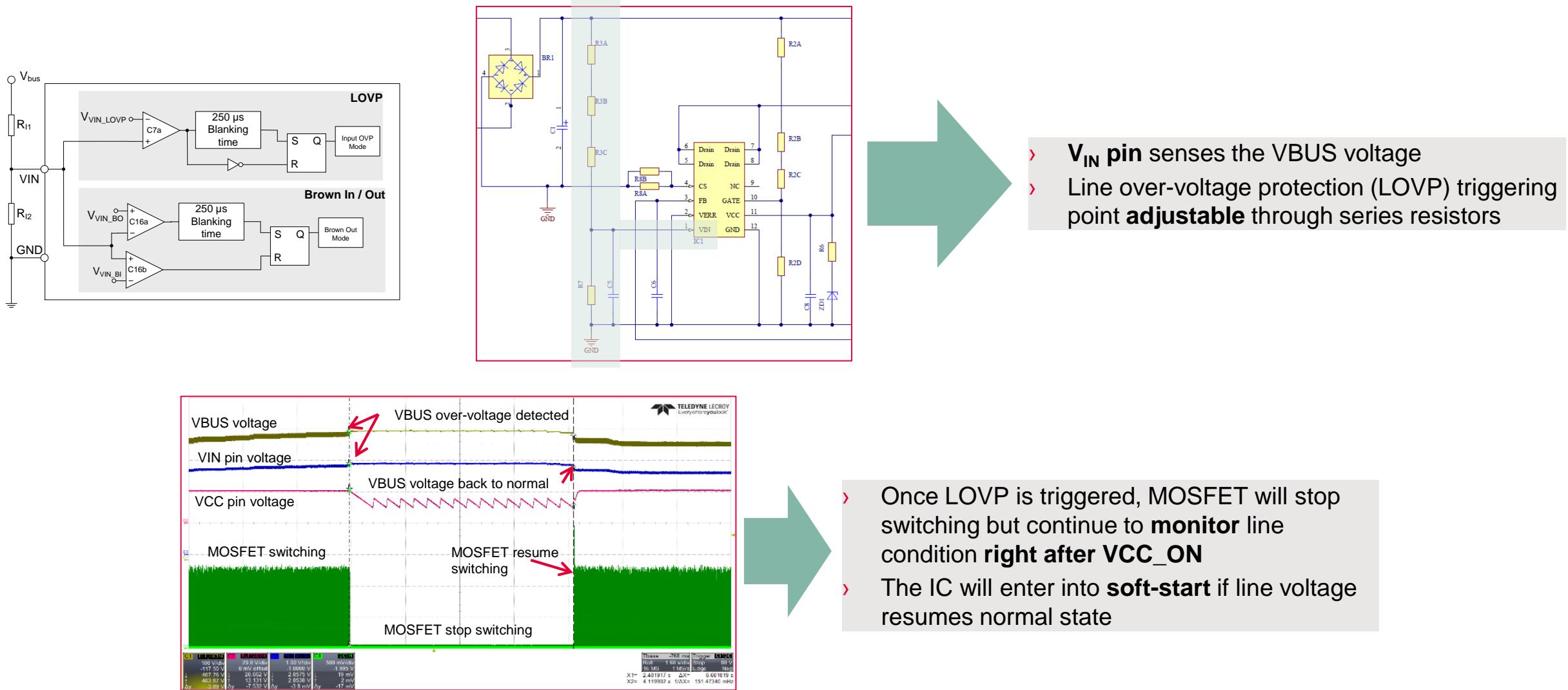


Figure 10 Current limiting

Propagation delay compensation is integrated to reduce the overshoot due to dI/dt of the rising primary current. The Current limiting becomes more accurate which will result in a minimum difference of overload protection triggering power between low and high AC line input voltage.

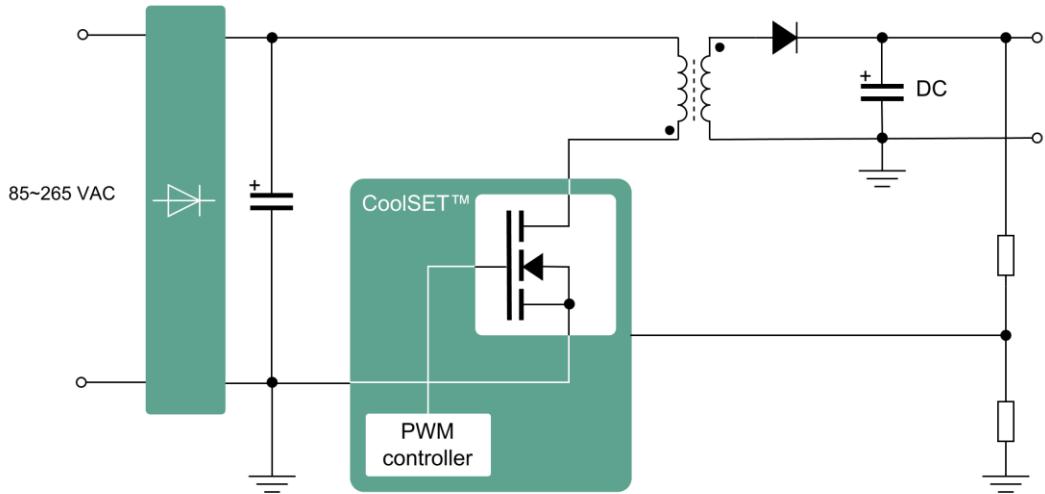
Dedicated Pin for Line Over/Under-voltage Protection



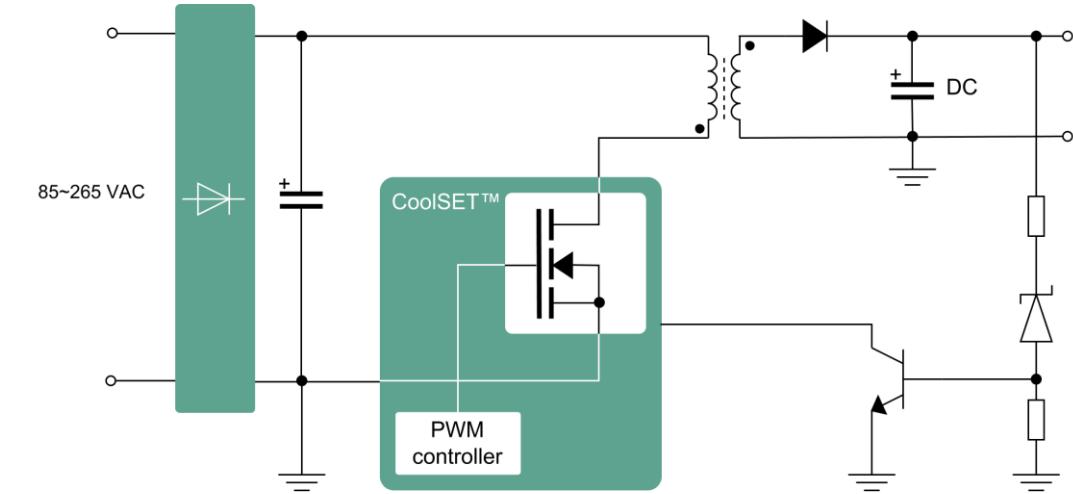
Key feature: BOM savings and ease of design with integrated error amplifier for non-isolated topologies



With integrated error amplifier



Without integrated error amplifier



- › Ease of design with integrated error amplifier for non-isolated configuration
- › BOM savings (e.g. 1x NPN transistor and 1x Zener diode)
- › Higher and consistent (e.g. across temperature) regulation accuracy

Table 6 Absolute maximum ratings

Parameter	Symbol	Limit values		Unit	Note or test condition
		Min.	Max.		
Drain voltage ICE5xRxx80xZ ICE5xR3995xZ	V_{DRAIN}	800 950	– –	V	$T_j = 25^\circ\text{C}$
Pulse drain current ICE5xR3995xZ ICE5BR4780BZ ICE5xR2280xZ	$I_{D,Pulse}$	– – –	5.0 ¹ 2.6 ¹ 5.8 ²	A	
Avalanche energy, repetitive, t_{AR} limited by maximal $T_j = 150^\circ\text{C}$ and $T_{j,Start} = 25^\circ\text{C}$ ICE5xR2280xZ ICE5BR4780BZ ICE5xR3995xZ	E_{AR}	– – –	0.05 0.02 0.04	mJ	$I_D = 0.40 \text{ A}, V_{DD} = 50 \text{ V}$ $I_D = 0.20 \text{ A}, V_{DD} = 50 \text{ V}$ $I_D = 0.20 \text{ A}, V_{DD} = 50 \text{ V}$
Avalanche current, repetitive, t_{AR} limited by maximal $T_j = 150^\circ\text{C}$ and $T_{j,Start} = 25^\circ\text{C}$ ICE5BR4780BZ ICE5xR3995xZ ICE5xR2280xZ	I_{AR}	– – –	0.20 0.20 0.40	A	
VCC supply voltage	V_{CC}	-0.3	27.0	V	
GATE voltage	V_{GATE}	-0.3	27.0	V	
FB voltage	V_{FB}	-0.3	3.6	V	
VERR voltage	V_{ERR}	-0.3	3.6	V	
CS voltage	V_{CS}	-0.3	3.6	V	
VIN voltage	V_{VIN}	-0.3	3.6	V	
Maximum DC current on any pin		-10.0	10.0	mA	Except DRAIN and CS pin.

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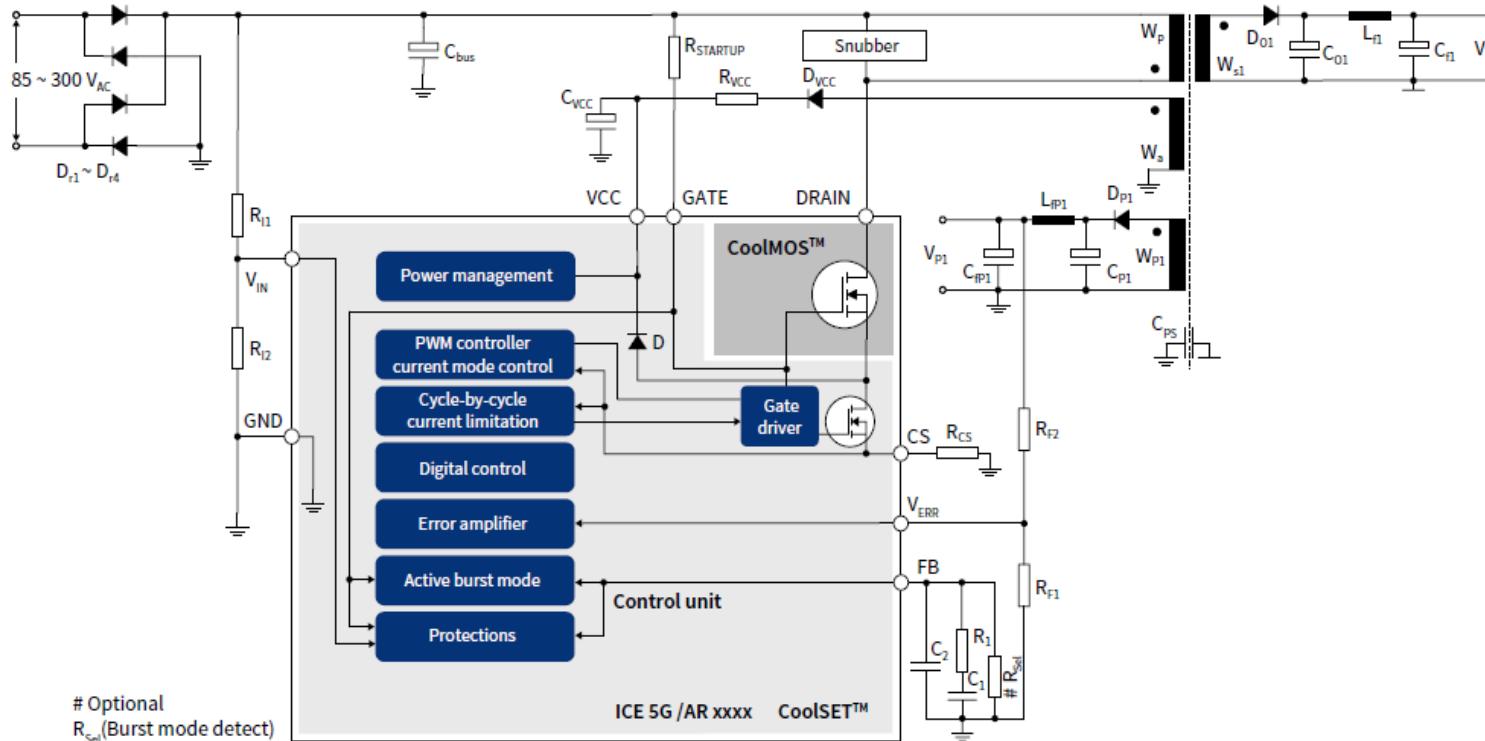
Product and system overview

5th generation: Fixed frequency flyback controllers and integrated power stages



System / application overview

Descriptions



The latest iteration of fixed frequency flyback controller and CoolSET™ offering high level of integration with an enhanced, comprehensive suite of protection features.

Key features

- Rapid and robust start-up
- Improve efficiency with frequency reduction
- 65 kHz, 100 kHz and 125 kHz switching frequency variant
- Supports both isolated and non-isolated flyback and buck topology
- Additional protection features
- Auto-restart mode
- High power integration with CoolMOS™ P7



Typical application as isolated flyback and non-isolated flyback converter

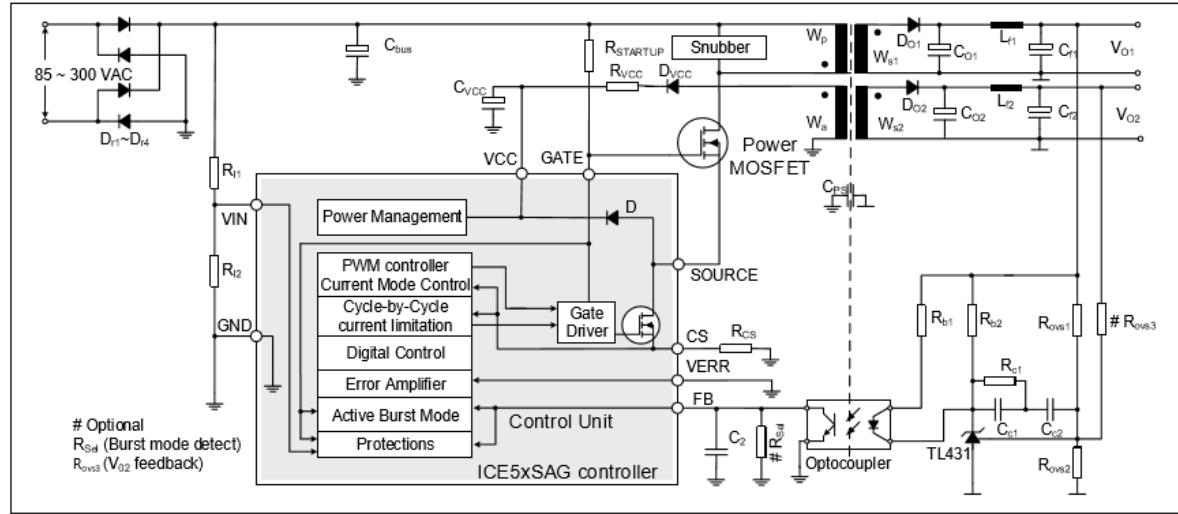


Figure 1 Typical application in isolated flyback using TL431 and optocoupler

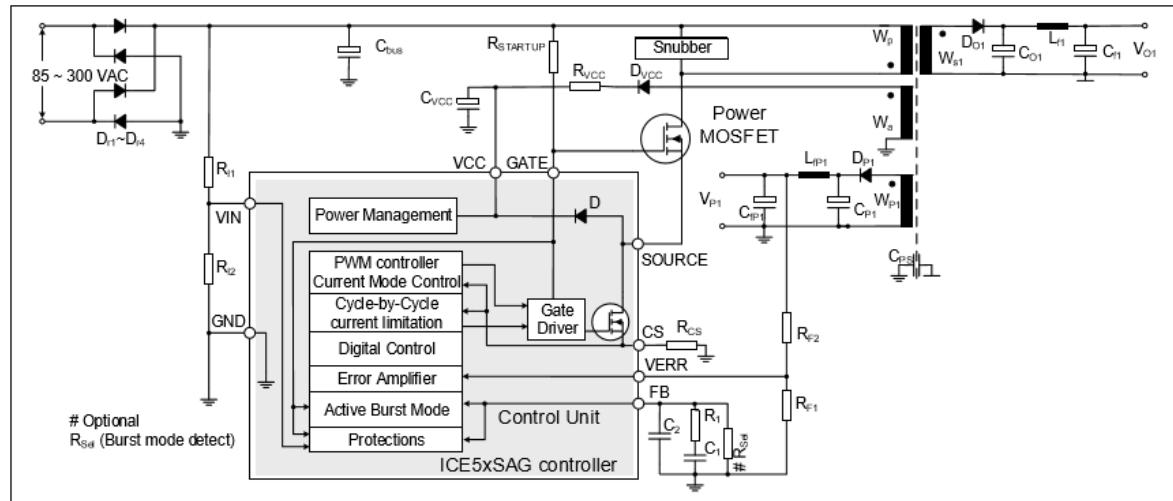
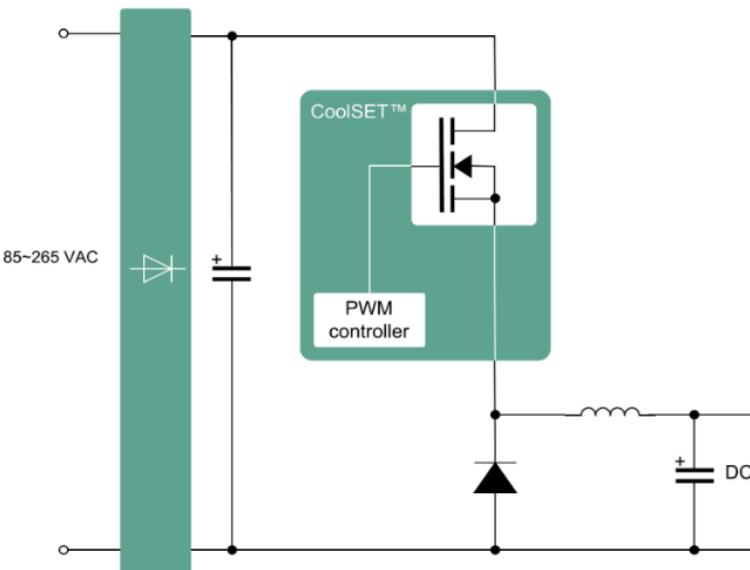
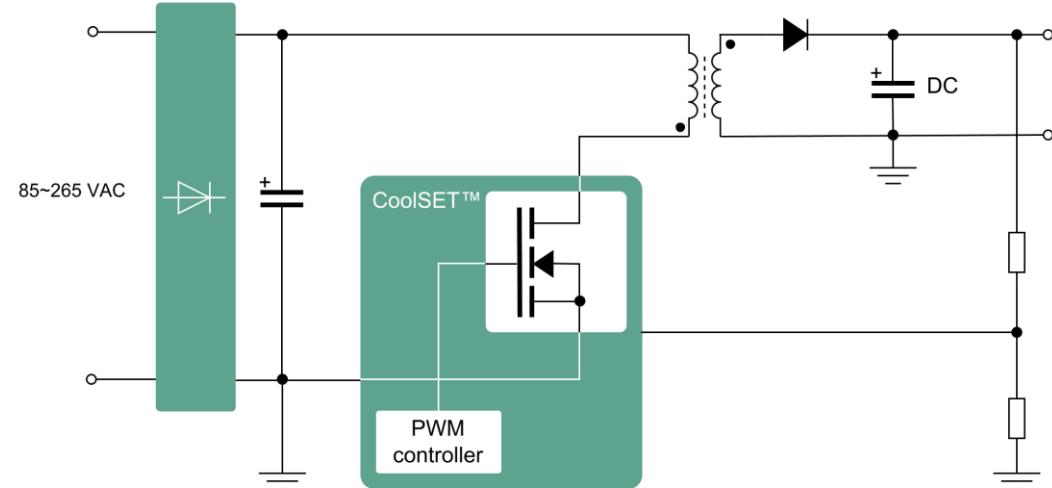
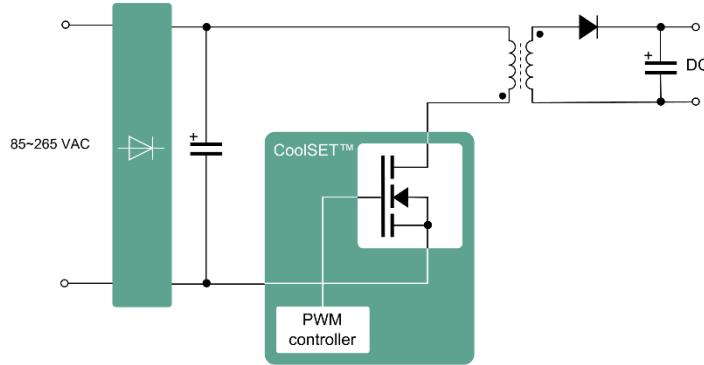


Figure 2 Typical application in non-isolated flyback utilizing integrated error amplifier

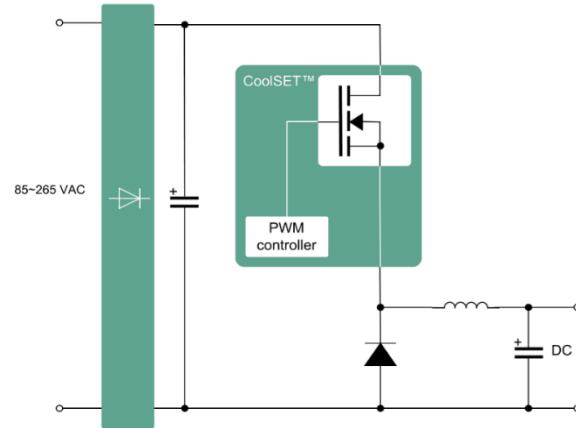


Target applications

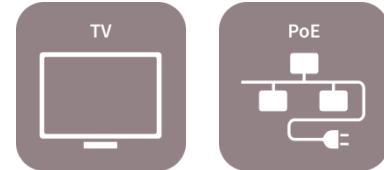
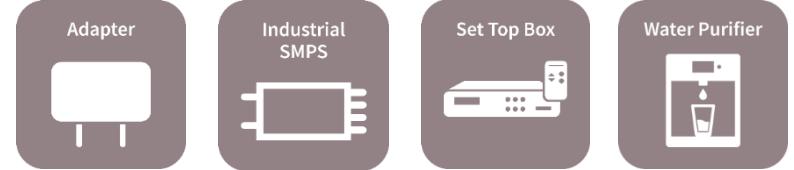
Isolated/non-isolated flyback



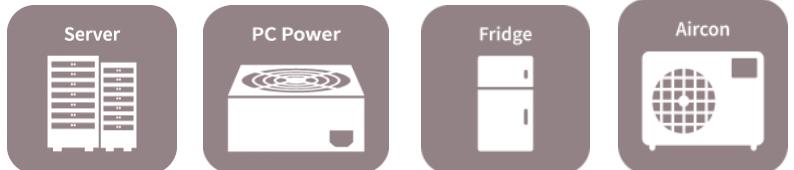
Non-isolated buck



Main power SMPS



Aux power SMPS



- › Offline auxiliary / bias power supply
- › Isolated and non-isolated flyback topology (up to 60 W)
- › Non-isolated buck topology (up to 700 mA)

Key features

5th generation: Fixed frequency flyback controllers and integrated power stages

› Key features

- 65 kHz, 100 kHz and 125 kHz switching frequency
- Improved EMI performance with frequency jittering
- Fixed frequency with frequency reduction (up to 2.35x)
- Integrated error amplifier for non-isolated flyback and buck topology (optional)
- Selectable active burst mode entry/exit profile (optional)
- DCM/CCM current control mode
- Cascode configuration for fast & robust start-up operation
- CoolSET™ offering with both 700 V, 800 V and 950 V CoolMOS™



› Protection (Auto-restart)

- Adjustable line input OVP
- Adjustable brown IN (optional)
- VCC over/under voltage
- VCC short to ground protection
- Open loop / overload / output short circuit protection
- OTP with hysteresis

› Package

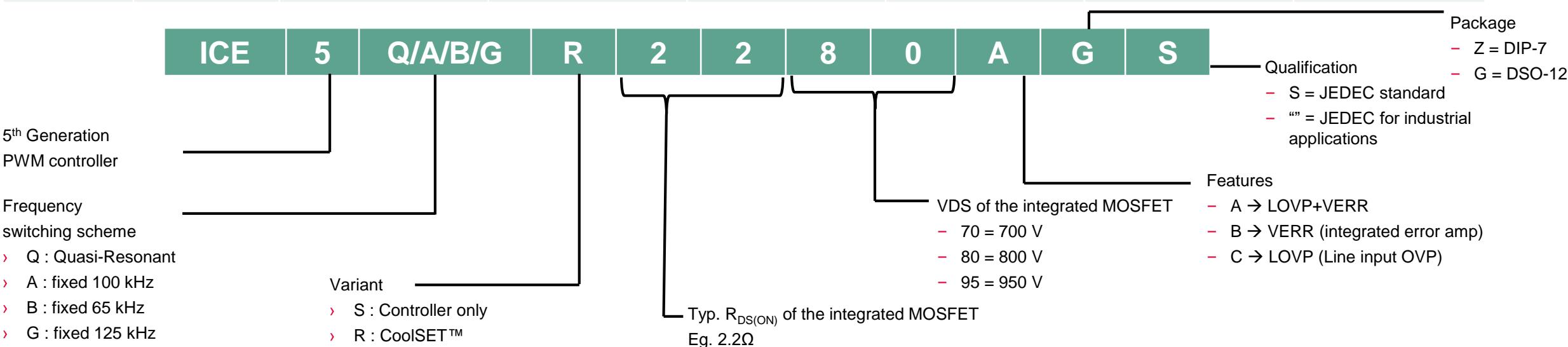
- Standalone controller – DSO-8
- CoolSET™ – DSO-12 and DIP-7

Portfolio



5th generation: Fixed frequency flyback controllers and integrated power stages

Max P _{out} 85~300 V _{AC} T _a =50°C		15 W	17 W	23 W	27 W	40 W	60 W
External	DSO-8						
700 V	DIP-7	ICE5AR4770BZS					
	DSO-12	ICE5AR4770AG					
800 V	DIP-7	ICE5AR4780BZS ICE5BR4780BZ		ICE5AR2280CZ ICE5BR2280BZ		ICE5AR0680BZS	
	DSO-12	ICE5GR4780AG		ICE5GR2280AG	ICE5GR1680AG	ICE5AR0680AG	
950 V	DIP-7		ICE5BR3995BZ ICE5BR3995CZ				



Gen5-FF Product Portfolio Extensions with 950V Integrated MOSFET— Buck and 3-Phase Designs



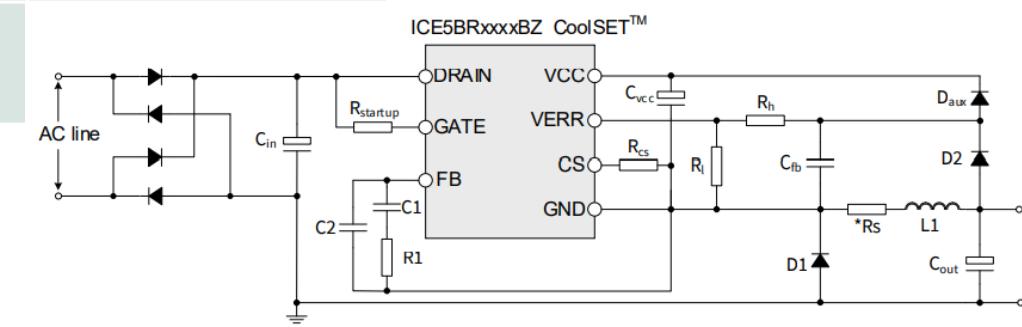
Max P _{out} 85~300 V _{AC} T _a =50°C	Max switching frequency	15 W	23 W	40 W
700 V	100 kHz	ICE5AR4770BZS		
800 V	100 kHz	ICE5AR4780BZS	ICE5AR2280CZ	ICE5AR0680BZ S
	65 kHz	ICE5BR4780BZ	ICE5BR2280BZ	
950 V	65 kHz	ICE5BR3995BZ		
		ICE5BR3995CZ		

- › ICE5ARxxxxxZx → 100 kHz
- › ICE5BRxxxxxZ → 65 kHz

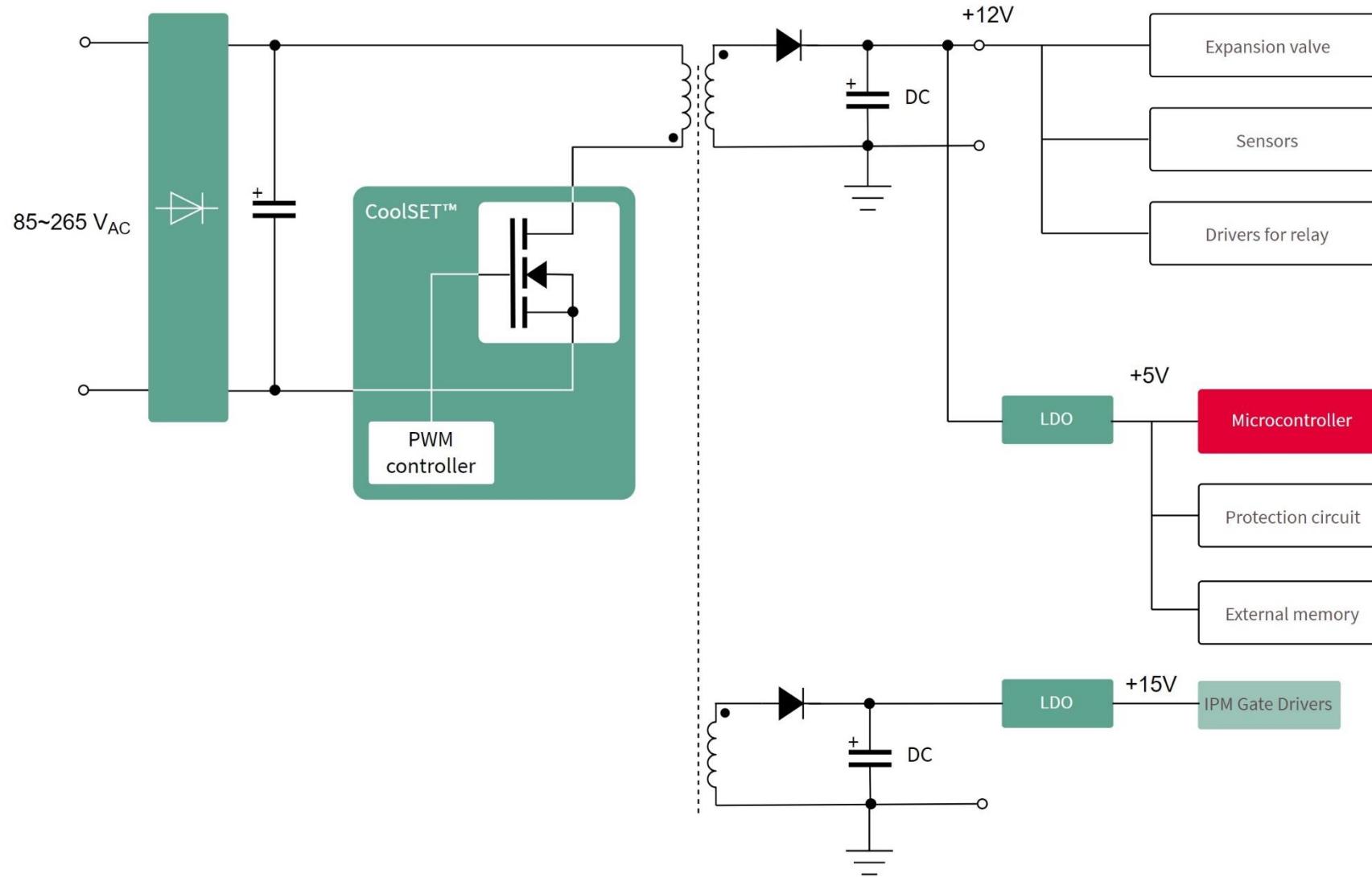
- › ICE5xRxxxxCZ
- › Line input over voltage protection



› 65kHz for Buck topologies



Application example: residential air-condition (Outdoor)



Why 5th generation fixed frequency CoolSET™ ?

	Features	Benefits	Addressed customers' needs
Strong arguments	Integrated LOVP, brown IN protection & error amplifier	BOM savings	<ul style="list-style-type: none"> Save more than 10 components for implementation via discrete components ~USD 0.05
	Frequency reduction	High efficiency at mid and light load	<ul style="list-style-type: none"> Reduced switching frequency at mid & light load to achieve higher efficiency
	Slope compensation for CCM	High power delivery	<ul style="list-style-type: none"> Highest power delivery in the market of up to 43 W with 800 V CoolSET™
	V _{CC} pin short to ground protection & enhanced OTP	Robust system protection	<ul style="list-style-type: none"> Avoid permanent damage to controller due to vital pins shorted to ground Avoid looping of protection mode due to absence of hysteresis during OTP
	Integrated P7 flyback optimized CoolMOS™	Run cooler with P7 CoolMOS™	<ul style="list-style-type: none"> Simplified and enhanced thermal performance
Medium arguments	Cascode configuration	Fast & robust startup	<ul style="list-style-type: none"> Utilizing the integrated CoolMOS™ to facilitate start-up with higher charging current enable faster start-up time
	Selectable active burst mode Entry/eExit profile	Optimize standby power	<ul style="list-style-type: none"> Flexibility in optimizing standby and light load performance with dual active burst node entry/exit profile to choose from
Soft arguments	Platform support	Fast time to market	<ul style="list-style-type: none"> High design reusability & interoperability across various power & regional requirements for fastest time-to-market

Demo board availability

(1/2)



Generation 5-FF

S/N	Part number	P _{out}	Output	Isolated	App note	Available @ ISAR
1	REF_5AR4770AG_3W1	3 W	5 V	Yes	Internet	Yes
2	EVAL_5BR3995BZ_BUCK1	5.4 W	18 V	No	Internet	Yes
3	EVAL_5BR4780BZ_450mA1	6.7 W	15 V	No	Internet	Yes
4	REF_5AR4770BZS_8W1	8 W	12 V, 5 V	Yes	Internet	Yes
5	REF_5BR2280BZ_700mA1	10.5 W	15 V	No	Internet	Yes
6	REF_5AR4770AG_13W1	13 W	12 V, 15 V	No	Internet	Yes
7	DEMO_5AR4770AG_14W1	14 W	15 V, 5 V	No	Internet	Yes
8	DEMO_5GR4780AG_14W1	14 W	15 V, 5 V	No	Internet	Yes
9	DEMO_5AR4780BZS_14W1	14 W	15 V, 5 V	No	Internet	Yes
7	REF_5AR4770BZS_15W1	15 W	12 V	Yes	Internet	Yes
8	REF_5AR4770AG_15W1	15 W	12 V, 15V	Yes / No	Internet	Yes
9	REF_5BR4780BZ_15W1	15 W	15 V, 12 V, 5 V	No	Internet	Yes
10	REF_5BR3995BZ_16W1	16 W	15 V, 12 V, 5 V	No	Internet	Yes
11	REF_5BR3995CZ_16W1	16 W	12 V, 5 V, 5 V	Yes	Internet	Yes
12	REF_5GSAG_18W1	18 W	12 V	Yes	Internet	Yes

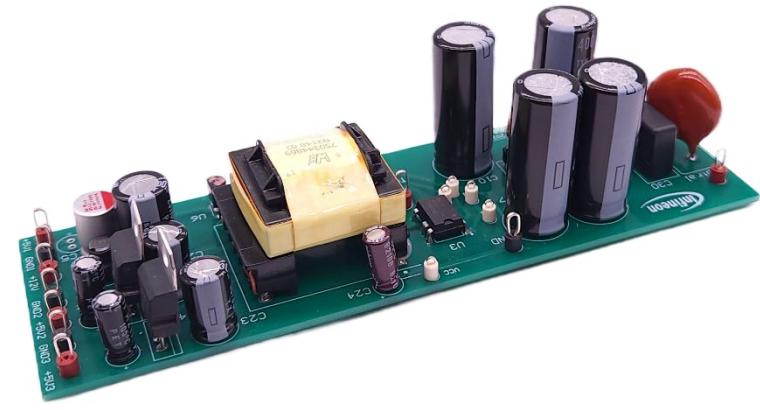
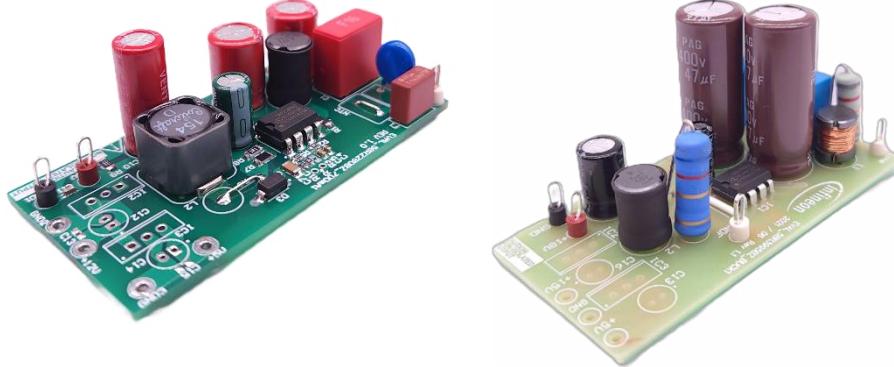
Demo board availability

(2/2)



Generation 5-FF

S/N	Part number	P _{out}	Output	Isolated	App note	Available @ ISAR
13	DEMO_5GR2280AG_22W1	22 W	12 V, 5 V	Yes	Internet	Yes
14	REF_5GR2280AG_22W1	22 W	15 V, 12 V, 20 V	No / Yes / Yes	Internet	Yes
15	REF_5BR2280BZ_22W1	22 W	15 V, 12 V, 5 V	No / Yes / Yes	Internet	Yes
16	REF_5AR2280CZ_22W1	22 W	15 V, 12 V, 5 V	No / Yes / Yes	Internet	Yes
17	DEMO_5GR1680AG_27W1	27 W	12 V, 5 V	Yes	Internet	Yes
18	DEMO_5AR0680AG_44W1	44 W	12 V	Yes	Internet	Yes
19	DEMO_5AR0680BZS_44W1	44 W	12 V	Yes	Internet	Yes
20	DEMO_5ASAG_60W1	60 W	12 V, 5 V	Yes	Internet	Yes
21	DEMO_5GSAG_60W1	60 W	19 V	Yes	Internet	Yes



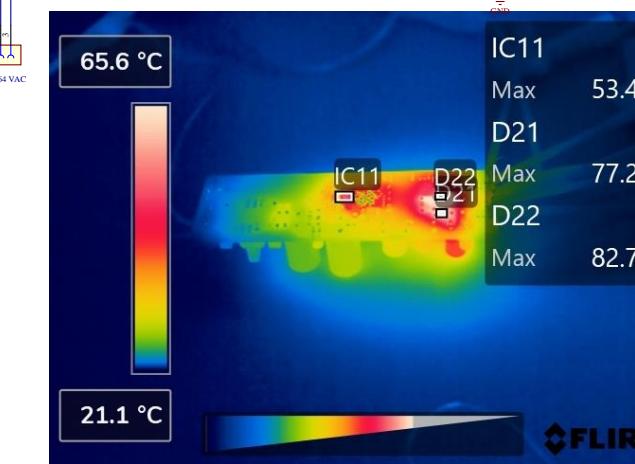
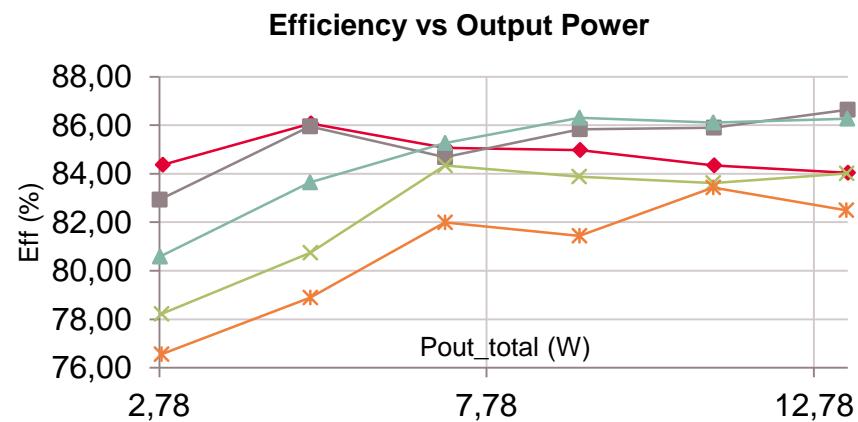
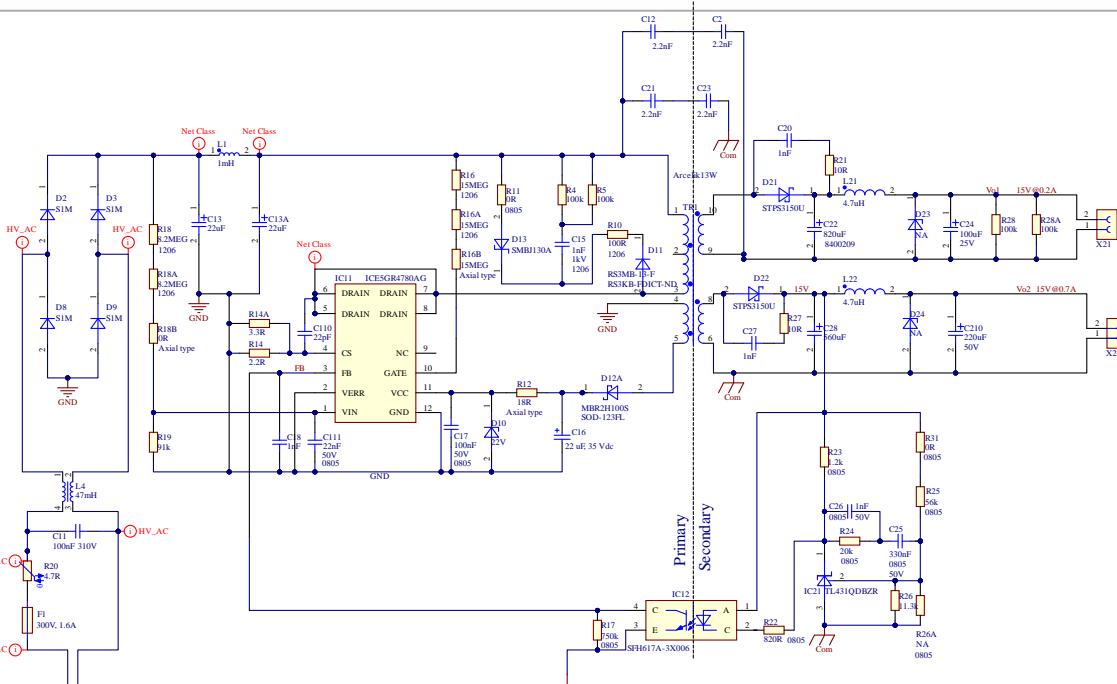
Infineon 5th generation CoolSET™

Auxiliary power supply evaluation boards for RAC application



Indoor RAC (isolated except 15 V rail)	Outdoor RAC (non-isolated)	Misc (non-isolated buck)
 REF 5AR4770BZS 8W1 Input: 85 ~ 265 V _{AC} Output #1: 12 V / 450 mA Output #2: 5 V / 500 mA	 REF 5AR4770AG 13W1 Input: 85 ~ 264 V _{AC} Output #1: 15 V / 150 mA Output #2: 12 V / 850 mA	 EVAL 5BR4780BZ 450mA1 Input: 85 ~ 264 V _{AC} Output: 15 V / 450 mA (6.7 W)
 REF 5AR4770AG 15W1 Input: 85 ~ 264 V _{AC} Output #1: 15 V / 150 mA Output #2: 12 V / 1000 mA	 REF 5BR4780BZ 15W1 Input: 85 ~ 264 V _{AC} Output #1: 15 V / 150 mA Output #2: 12 V / 800 mA Output #3: 5 V / 300 mA	 EVAL 5BR2280BZ 700mA1 Input: 85 ~ 264 V _{AC} Output: 15 V / 700 mA (10.5 W)
 REF 5BR2280BZ 22W1 Input: 85 ~ 264 V _{AC} Output #1: 15 V / 150 mA Output #2: 12 V / 1400 mA Output #3: 5 V / 300 mA	 REF 5BR3995BZ 16W1 Input: 85 ~ 264 V _{AC} Output #1: 15 V / 150 mA Output #2: 12 V / 900 mA Output #3: 5 V / 300 mA	 EVAL 5BR3995BZ BUCK1 Input: 85 ~ 460 V _{AC} Output: 18 V / 300 mA (5.4 W)

Double output 13.5W design with ICE5GR4780AG – Induction Cooking 800V MOSFET integrated



- 85~264 V_{AC} (Up to 440 VAC wrong phase connection)
- 22°C Above ambient temperature
- Peak Power: 13.5 W
- Isolated output: 15 V / 700 mA
- Isolated output: 15 V / 200 mA)
- Standby < 50 mW

Summary

- › **Comprehensive suite of protections**
 - Robust line input and pin protection
 - Auto-restart recovery mode
- › **High performance**
 - Frequency reduction for high efficiency at mid and light load conditions
 - Integrated CoolMOS™ P7 superjunction MOSFET
- › **High power delivery**
 - Highest power delivery (without heatsink) in the market with 800 V SMD CoolSET™ of up to 60 W
 - Highest non-isolated buck output current support up to 700 mA among top tier suppliers
 - Integrated slope compensation to support CCM operation
- › **High integration**
 - Integrated error amplifier to support direct feedback for non-isolated flyback or buck topology design
- › **Wide portfolio**
 - Choice of 700 V, 800 V and 950 V integrated MOSFET
 - Infineon's first CoolSET™ with 125 kHz switching frequency (on top of 65 kHz and 100 kHz)

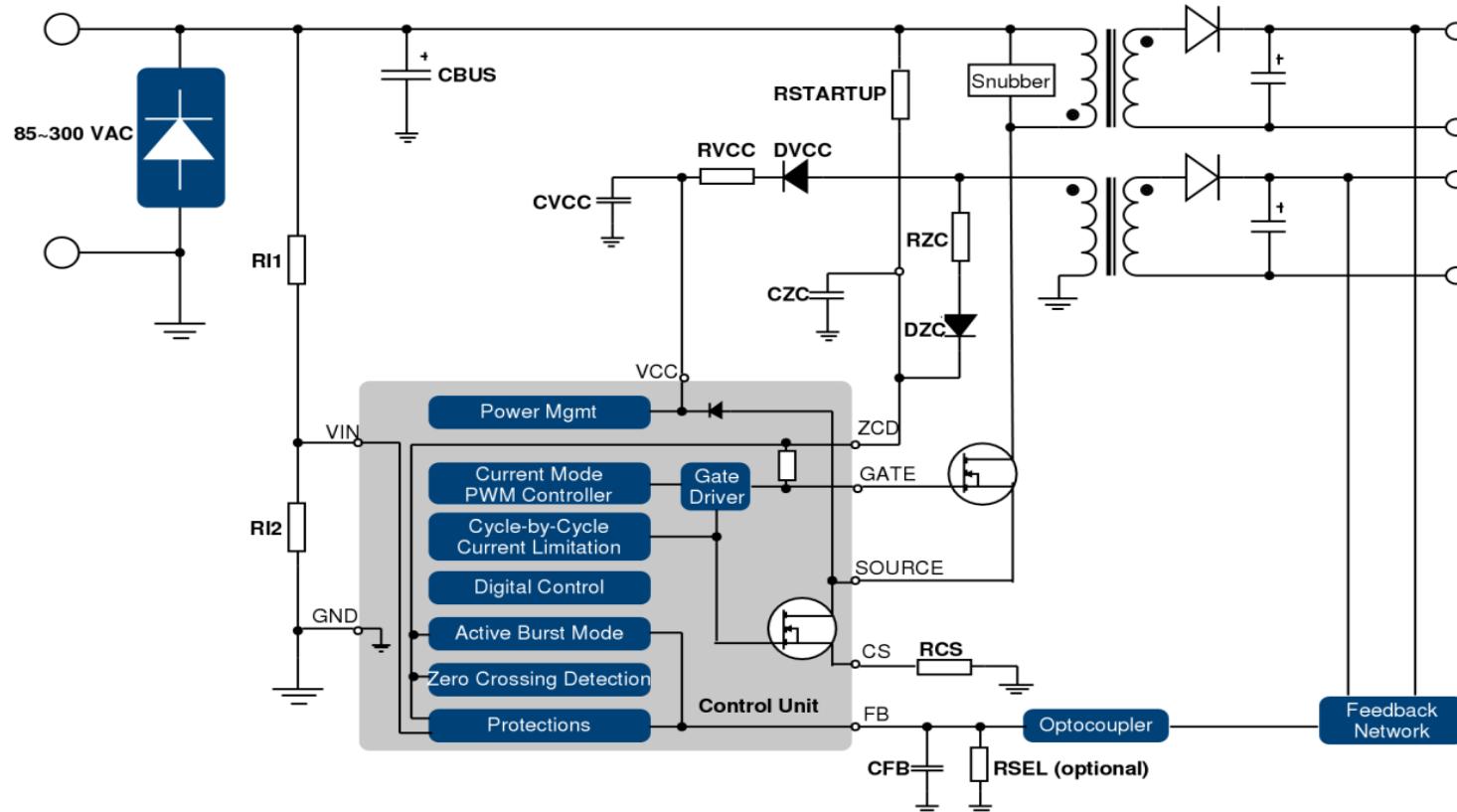
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5th generation quasi-resonant Product / system overview



System / application overview



Descriptions

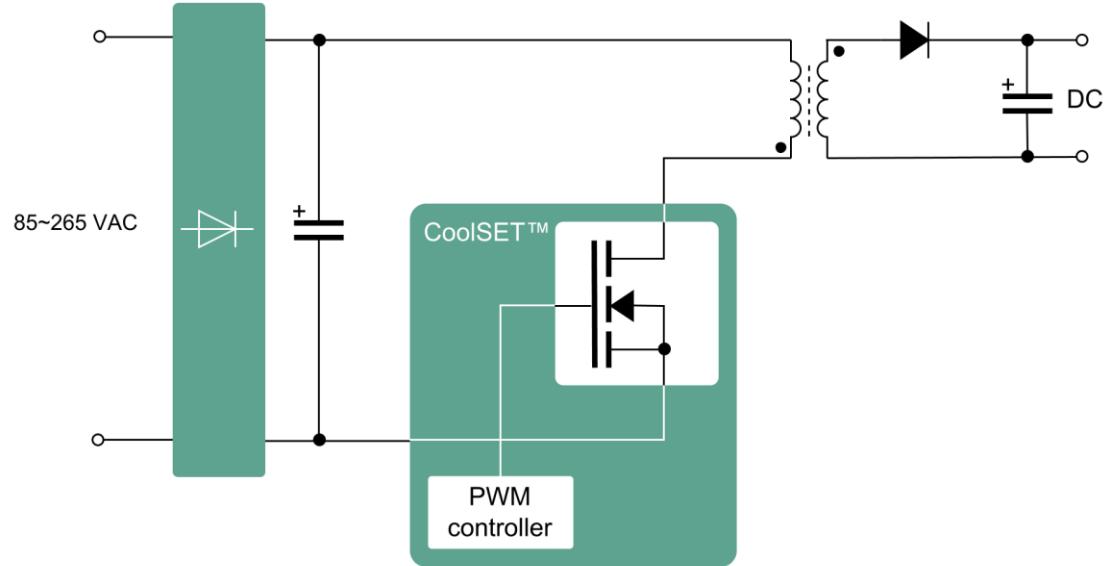
- Latest iteration of quasi resonant flyback controller offering high level of integration with enhanced and comprehensive suite of protection

Key Features

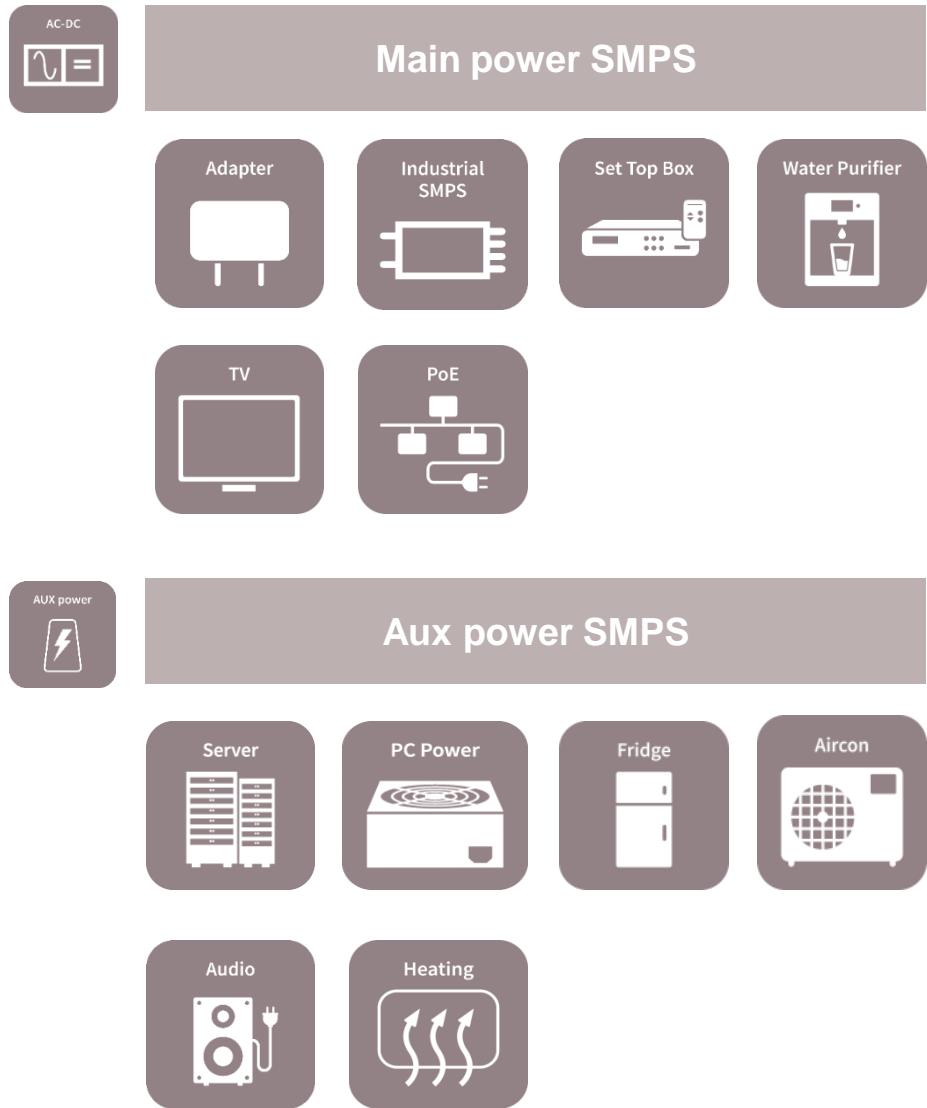
- Rapid and robust start-up
- Improve efficiency
- Additional protection features
- Auto-restart mode
- High power integration with P7 CoolMOS™



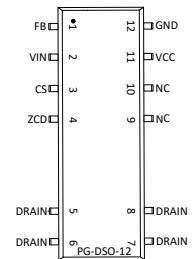
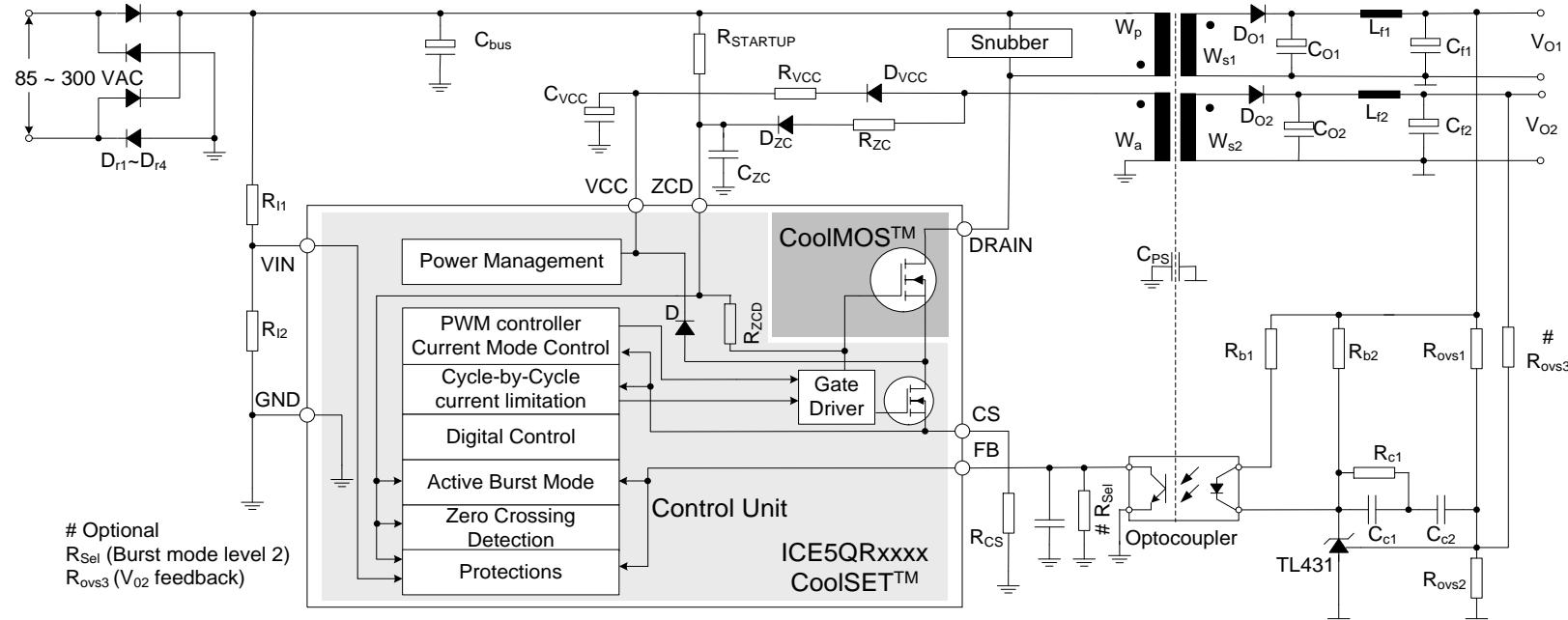
Target applications



- › Offline switch mode power supply
- › Isolated flyback topology
- › Output power 60 W or less



Proposed system approach for SMPS 10 W ~ 42 W



Product highlights

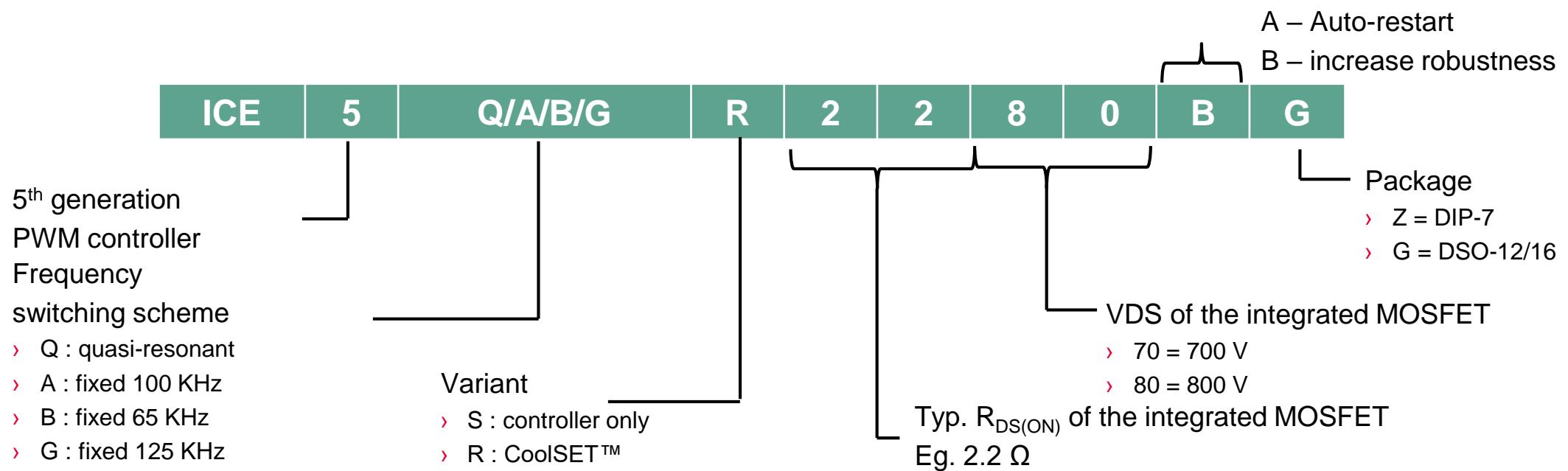
- › **800 V CoolMOS™**
- › **2x fast startup** achieved with cascode configuration
- › **Improved active burst mode** with **selectable entry/exit thresholds** to lower standby power
- › **Novel quasi-resonant operation** and proprietary implementation **for low EMI**
- › **Digital frequency reduction** up to 10th valley @ high line for better light load efficiency
- › Robust line protection with **adjustable input OVP** and **brownout protection**.
- › All protection to be **auto-restart**
- › Comprehensive protection features to protect the IC and the system from various fault conditions

Why gen 5 quasi resonant ?

	Features	Benefits	Addressed customers' needs
Strong arguments	Integrated LOVP & brown IN/OUT protection	BOM savings	<ul style="list-style-type: none"> › Save more than 10 components for implementation via discrete components ~USD 0.05
	Novel quasi resonant switching	Increase efficiency & minimize audible noise at light load	<ul style="list-style-type: none"> › Upsized zero crossing counters to achieve deeper frequency reduction › Narrow active burst mode entry/exit power under different line condition
	Vcc pin short to ground protection & enhanced OTP	Robust system protection	<ul style="list-style-type: none"> › Avoid permanent damage to controller due to vital pins shorted to ground › Avoid looping of protection mode due to absence of hysteresis during OTP
	Integrated P7 flyback optimized CoolMOS™	Run cooler with P7 CoolMOS™	<ul style="list-style-type: none"> › Simplified and enhanced thermal performance
Medium arguments	Cascode configuration	Fast & robust startup	<ul style="list-style-type: none"> › Utilizing the integrated CoolMOS™ to facilitate start-up with higher charging current enable faster start-up time
	Selectable active burst mode entry/exit profile	Optimize standby power	<ul style="list-style-type: none"> › Flexibility in optimizing standby and light load performance with dual active burst mode entry/exit profile to choose from
Soft arguments	Integration of low $R_{DS(ON)}$ CoolMOS™	High power delivery in small form factor	<ul style="list-style-type: none"> › Up to 42 W offering in an integrated device and without the utilization of bulky heatsink

Gen 5 quasi CoolSET™ and standalone controller family

Max Pout 85~300 V _{AC} Ta=50°C	15 W	22 W	27 W	32 W	41-42 W	60 W
DSO-8						ICE5QSAG ICE5QSBG
DSO-12	ICE5QR4780BG	ICE5QR2280BG	ICE5QR1680BG		ICE5QR0680BG	



Gen 5 quasi resonant demoboard availability

S/N	Part number	P _{out}	App note	Available @ ISAR
1	DEMO_5QR4780BG_15W1	16 W	Internet	Yes
2	DEMO_5QR2280BG_24W1	24 W	Internet	Yes
3	DEMO_5QR1680BG_27W1	27 W	Internet	Yes
4	REF_5QSBG_33W1	33 W	Internet	Yes
5	REF_5QR1680BG_30W1	30 W	Upcoming	Upcoming
6	DEMO_5QR0680BG_42W1	42 W	Internet	Yes
7	DEMO_5QSBG_60W1	60 W	Internet	Yes

Summary

- › Gen 5 quasi resonant is the first wave of various flyback products to be launched
 - Fixed frequency variant and standard grade available to further compliment the portfolio
- › Various new features introduced with gen 5 quasi resonant
 - Cascode configuration
 - Novel quasi resonant switching scheme
 - Selectable active burst mode
 - Robust line input and pin protection
 - Fully auto-restart protection scheme

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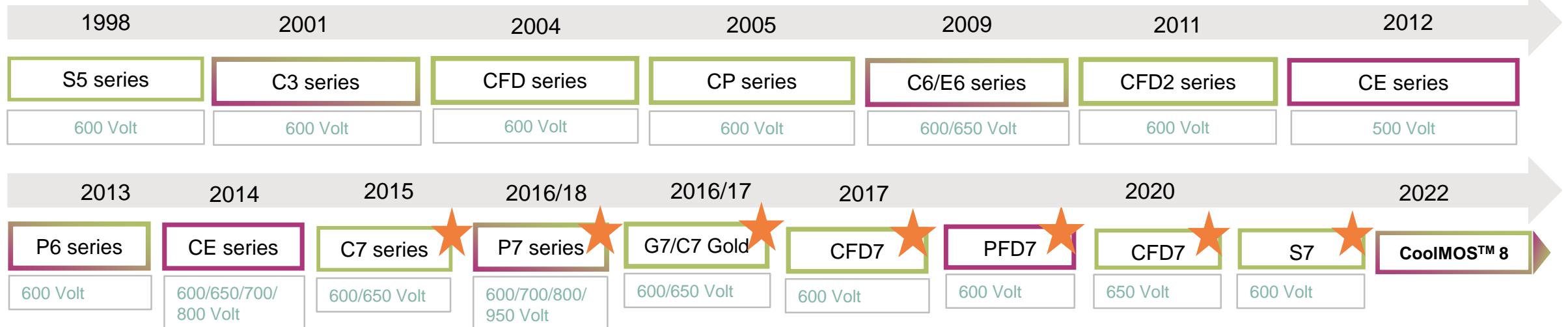
1	Gen 5 fixed frequency flyback controller - CoolSet	12
2	Gen 5 quasi-resonant flyback controller - CoolSet	26
3	CoolMos P7, CoolGaN and CoolSiC for SMPS application	34
4	SMPS Design Tool – PowerESIM for CoolSET™	49

Infineon - Inventor of superjunction

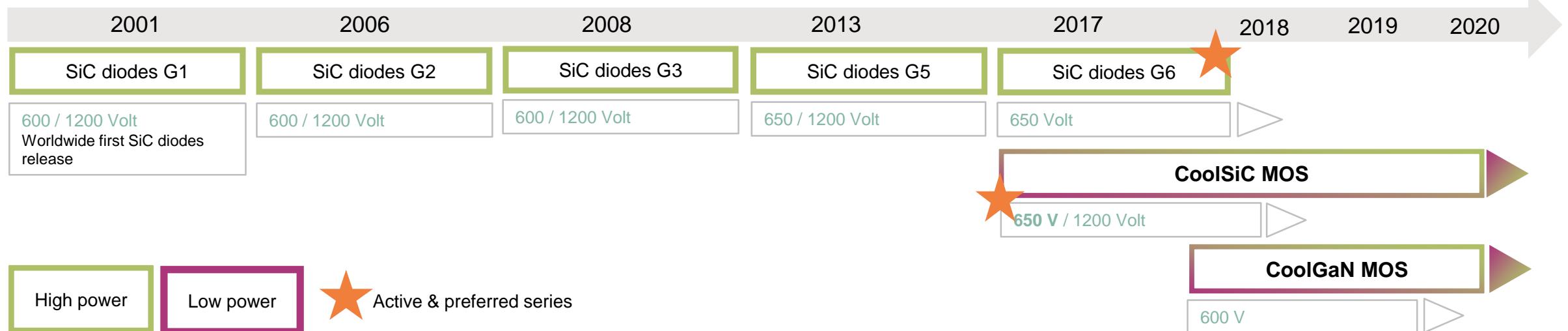
Long-standing experience for 19 years



CoolMOS™ – Silicon technologies



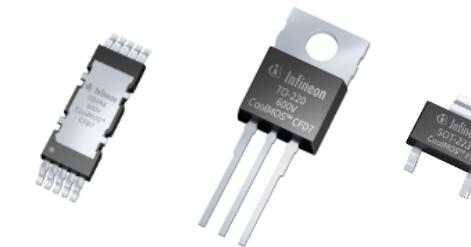
CoolSiC™ and CoolGaN™ wide bandgap technologies



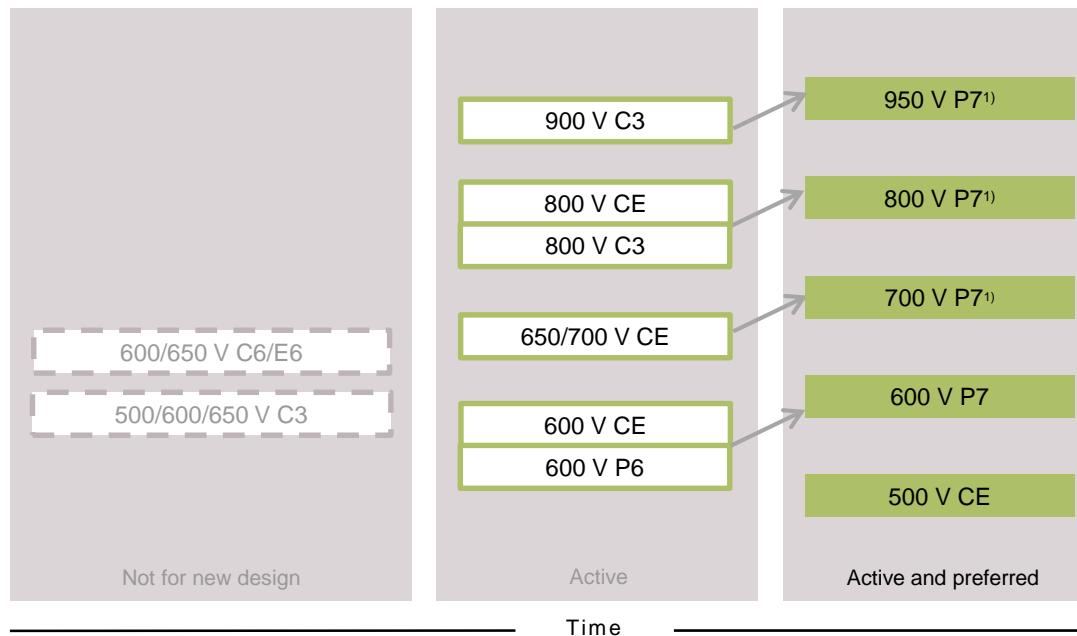
CoolMOS™ positioning within high and low power SMPS market



CoolMOS™ SJ MOSFET for low power SMPS (<150 W)



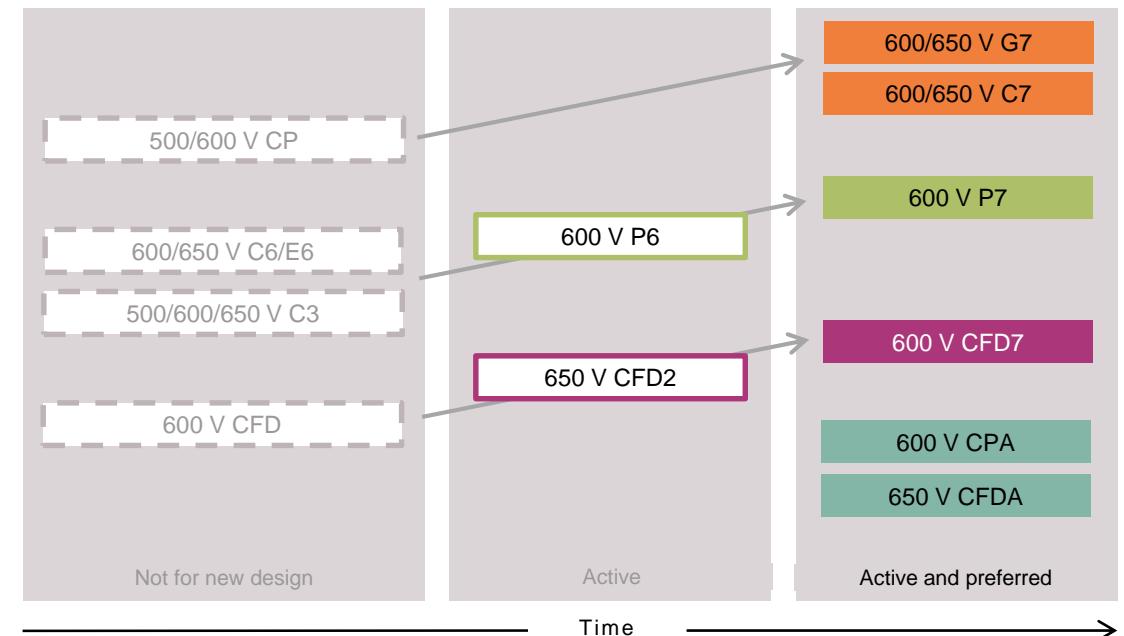
CoolMOS™ SJ MOSFET for high power SMPS (>150 W) and automotive



¹⁾ Optimized for flyback topologies

Price-performance

Highest performance



Fast recovery diode

Automotive

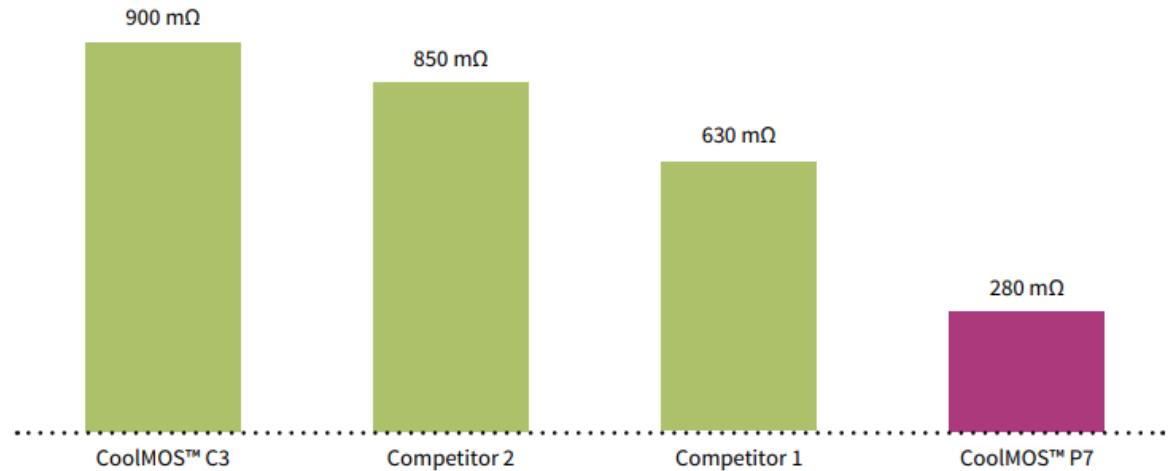
CoolMOS™ P7 – Smaller Die Size Enhances IC Cost Effectiveness

Best in Class MOSFET

- › 950V, 800V and 700V MOSFET
- › Specified avalanche energy for increased robustness
- › Best-in-class $R_{DS(on)}$ vs die size
- › Best-in-class FOM $R_{DS(on)} * E_{oss}$; reduced Q_g , C_{iss} and C_{oss}
- › Best-in-class $V_{(GS)th}$ of 3 V
- › Smallest $V_{(GS)th}$ variation of ± 0.5 V
- › Integrated Zener Diode ESD protection up to Class 2 (HBM)

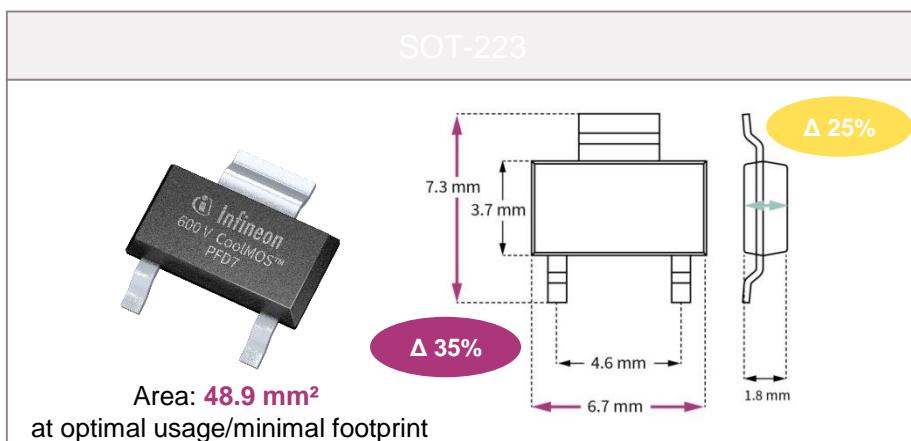
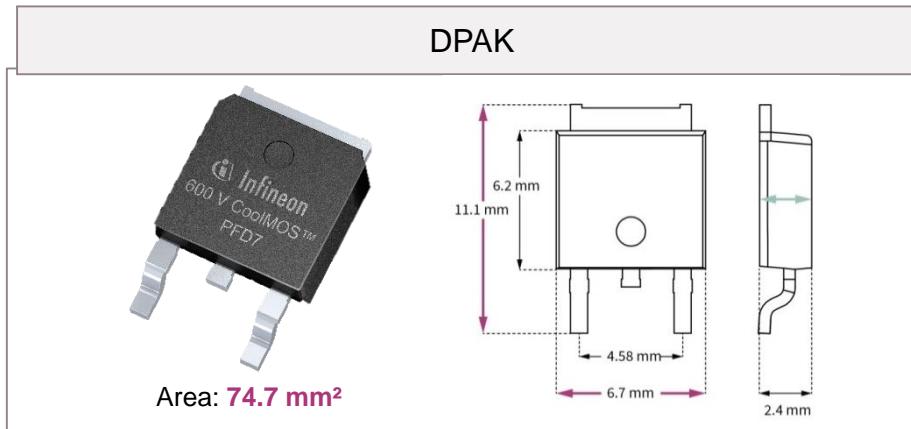


Overview of lowest DPAK $R_{DS(on)}$ for 800 V superjunction MOSFETs



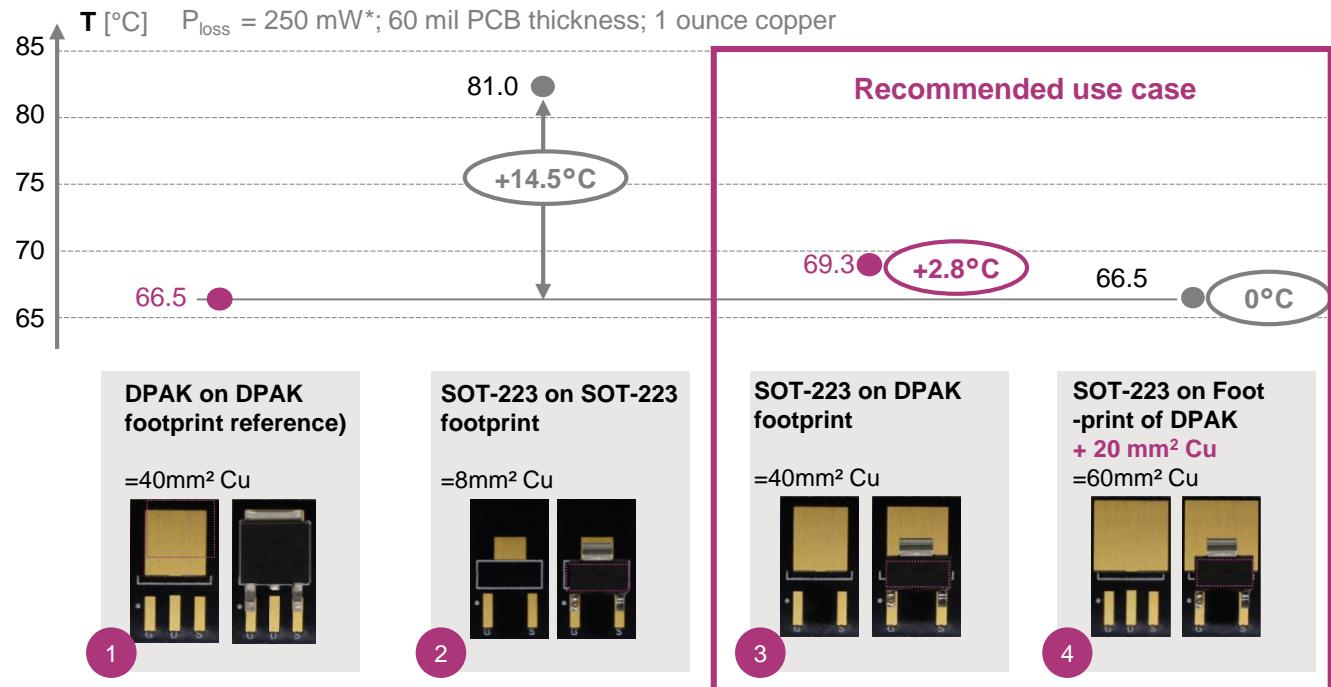
800 V CoolMOS™ P7 sets benchmark in best-in-class DPAK $R_{DS(on)}$

Our recommendation: the cost effective SOT-223 package offers smaller footprint while being pin-to-pin compatible with DPAK



Thermal performance similar to DPAK

- › The thermal behavior of the SOT-223 depends on layout of the board and on the power dissipated:



* Evaluated on internal IFX test PCBs; results independent of technology

The SOT-223 package is a suitable drop-in replacement for DPAK at lower cost, enabling space savings in designs with low power dissipation.

Learn more: www.infineon.com/sot-223 www.infineon.com/600v-pfd7

Recommended 600 - 950 V CoolIMOSTM P7 SJ MOSFETs for AUX power & PFC stages in Home Appliances



		950 V CoolIMOS™ P7 SJ MOSFETs														
		Industrial Grade														
HBM Class	R _{DS(on)} [mΩ]	800 V CoolIMOS™ P7 SJ MOSFETs														
		Industrial Grade														
HBM Class	R _{DS(on)} [mΩ]	700 V CoolIMOS™ P7 SJ MOSFETs														
2 (>2kV)	1C (>1kV)	* Coming soon	HBM class	R _{DS(on)} [mΩ]	700 V CoolIMOS™ P7 SJ MOSFETs											
					Industrial Grade											
					Standard Grade											
					600 V CoolIMOS™ P7 SJ MOSFETs											
					HBM class	R _{DS(on)} [mΩ]	TO-247	TO247-4	TO-220	TO-220 FullPAK	TO-220 FP NL	TO-220 FP WC	TO-252 DPAK	TO-263 D ² PAK		
2 (>2kV)	2 <td data-kind="parent" data-rs="10">*Coming soon</td> <td data-kind="parent" data-rs="10">HBM class</td> <td data-kind="parent" data-rs="10">R_{DS(on)} [mΩ]</td> <td data-cs="10" data-kind="parent">Industrial Grade</td> <td data-kind="ghost"></td>	*Coming soon	HBM class	R _{DS(on)} [mΩ]	Industrial Grade											
2 <td data-kind="parent" data-rs="10">2<br (>2kv)<="" td=""/><td data-kind="parent" data-rs="10">2<br (>2kv)<="" td=""/><td data-kind="parent" data-rs="10">HBM class</td><td data-kind="parent" data-rs="10">R_{DS(on)} [mΩ]</td><td data-cs="10" data-kind="parent">Standard Grade</td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td></td></td>	2 <td data-kind="parent" data-rs="10">2<br (>2kv)<="" td=""/><td data-kind="parent" data-rs="10">HBM class</td><td data-kind="parent" data-rs="10">R_{DS(on)} [mΩ]</td><td data-cs="10" data-kind="parent">Standard Grade</td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td><td data-kind="ghost"></td></td>	2 <td data-kind="parent" data-rs="10">HBM class</td> <td data-kind="parent" data-rs="10">R_{DS(on)} [mΩ]</td> <td data-cs="10" data-kind="parent">Standard Grade</td> <td data-kind="ghost"></td>	HBM class	R _{DS(on)} [mΩ]	Standard Grade											



Recommendation:
SOT-223, the cost-effective drop-in replacement for DPAK



Learn more:
www.infineon.com/coolmos

600 V CoolMOS™ P7 portfolio

	$R_{DS(on)}$ [mΩ] Max.	DPAK	D ² PAK	ThinPAK 8x8	TO220 FullPAK	TO220	TO220 FP NL	TO220 FP WC	TO247	TO247-4	SOT223
Industrial Grade	600	IPD60R600P7			IPA60R600P7	IPP60R600P7					
	360/365	IPD60R360P7	IPB60R360P7	IPL60R365P7	IPA60R360P7	IPP60R360P7					
	280/285	IPD60R280P7	IPB60R280P7	IPL60R285P7	IPA60R280P7	IPP60R280P7					
	180/185	IPD60R180P7	IPB60R180P7	IPL60R185P7	IPA60R180P7	IPP60R180P7			IPW60R180P7	IPZA60R180P7	
	160				IPA60R160P7	IPP60R160P7					
	120/125		IPB60R120P7	IPL60R125P7	IPA60R120P7	IPP60R120P7			IPW60R120P7	IPZA60R120P7	
	99/105		IPB60R099P7	IPL60R105P7	IPA60R099P7	IPP60R099P7			IPW60R099P7	IPZA60R099P7	
	80		IPB60R080P7	IPL60R085P7	IPA60R080P7	IPP60R080P7			IPW60R080P7	IPZA60R080P7	
	60/65		IPB60R060P7	IPL60R065P7	IPA60R060P7	IPP60R060P7			IPW60R060P7	IPZA60R060P7	
	45		IPB60R045P7						IPW60R045P7	IPZA60R045P7	
	37								IPW60R037P7	IPZA60R037P7	
	24								IPW60R024P7	IPZA60R024P7	
Standard Grade	600	IPD60R600P7S			IPA60R600P7S		IPAN60R600P7S	IPAW60R600P7S			IPN60R600P7S
	360	IPD60R360P7S			IPA60R360P7S		IPAN60R360P7S	IPAW60R360P7S			IPN60R360P7S
	280	IPD60R280P7S			IPA60R280P7S		IPAN60R280P7S	IPAW60R280P7S			
	180	IPD60R180P7S			IPA60R180P7S		IPAN60R180P7S	IPAW60R180P7S			

HBM : over 2kV



- Large $R_{DS(on)}$ and package variety
- Offering through hole and SMD packages
- Suitable for a wide variety of applications and power ranges

700 V CoolMOS™ P7 product portfolio

Recommended for PFC/flyback topologies**



700 V CoolMOS™ P7 SJ MOSFETs

HBM class	$R_{DS(on)}$ [mΩ]	Standard grade						Industrial grade
		TO-220 FullPAK	TO-220 FP narrow lead	TO-251 IPAK SL	TO-251 IPAK SL w/ ISO lead standoff	TO-252 DPAK	SOT-223	
1C (>1 kV)	2000				IPSA70R2K0P7S		IPN70R2K0P7S	IPLK70R2K0P7*
	1400			IPS70R1K4P7S	IPSA70R1K4P7S	IPD70R1K4P7S	IPN70R1K4P7S	IPLK70R1K4P7*
	1200				IPSA70R1K2P7S		IPN70R1K2P7S	IPLK70R1K2P7*
	900	IPA70R900P7S	IPAN70R900P7S	IPS70R900P7S	IPSA70R900P7S	IPD70R900P7S	IPN70R900P7S	IPLK70R900P7*
	750	IPA70R750P7S	IPAN70R750P7S		IPSA70R750P7S		IPN70R750P7S	IPLK70R750P7*
2 (>2 kV)	600	IPA70R600P7S	IPAN70R600P7S	IPS70R600P7S	IPSA70R600P7S	IPD70R600P7S	IPN70R600P7S	IPLK70R600P7*
	450	IPA70R450P7S	IPAN70R450P7S		IPSA70R450P7S		IPN70R450P7S	
	360	IPA70R360P7S	IPAN70R360P7S	IPS70R360P7S	IPSA70R360P7S	IPD70R360P7S	IPN70R360P7S	

** Excluding half and full bridge configurations

800 V CoolMOS™ P7 product portfolio

Recommended for PFC/flyback topologies**



800 V CoolMOS™ P7 SJ MOSFETs

HBM class	$R_{DS(on)}$ [mΩ]	Industrial grade								NEW package
		TO-247	TO-220	TO-220 FullPAK	TO-220 narrow lead	TO-251 IPAK LL	TO-251 IPAK SL	TO-252 DPAK	SOT-223	
1C (>1kV)	4500					IPU80R4K5P7		IPD80R4K5P7	IPN80R4K5P7	
	3300					IPU80R3K3P7		IPD80R3K3P7	IPN80R3K3P7	
	2400					IPU80R2K4P7	IPS80R2K4P7	IPD80R2K4P7	IPN80R2K4P7	
	2000					IPU80R2K0P7	IPS80R2K0P7	IPD80R2K0P7	IPN80R2K0P7	IPLK80R2K0P7*
2 (>2kV)	1400		IPP80R1K4P7	IPA80R1K4P7		IPU80R1K4P7	IPS80R1K4P7	IPD80R1K4P7	IPN80R1K4P7	IPLK80R1K4P7*
	1200		IPP80R1K2P7	IPA80R1K2P7		IPU80R1K2P7	IPS80R1K2P7	IPD80R1K2P7	IPN80R1K2P7	IPLK80R1K2P7*
	900		IPP80R900P7	IPA80R900P7		IPU80R900P7	IPS80R900P7	IPD80R900P7	IPN80R900P7	IPLK80R900P7*
	750		IPP80R750P7	IPA80R750P7		IPU80R750P7	IPS80R750P7	IPD80R750P7	IPN80R750P7	IPLK80R750P7*
	600		IPP80R600P7	IPA80R600P7		IPU80R600P7	IPS80R600P7	IPD80R600P7	IPN80R600P7	IPLK80R600P7*
	450		IPP80R450P7	IPA80R450P7	IPAN80R450P7			IPD80R450P7		
	360	IPW80R360P7	IPP80R360P7	IPA80R360P7	IPAN80R360P7			IPD80R360P7		
	280	IPW80R280P7	IPP80R280P7	IPA80R280P7	IPAN80R280P7			IPD80R280P7		

A wide range of products ensure to easily cover all target applications!

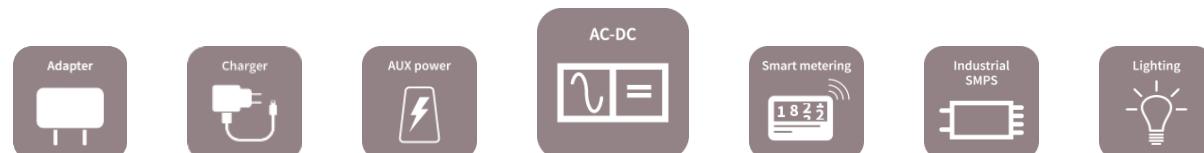
* Coming soon

** Excluding half and full bridge configurations

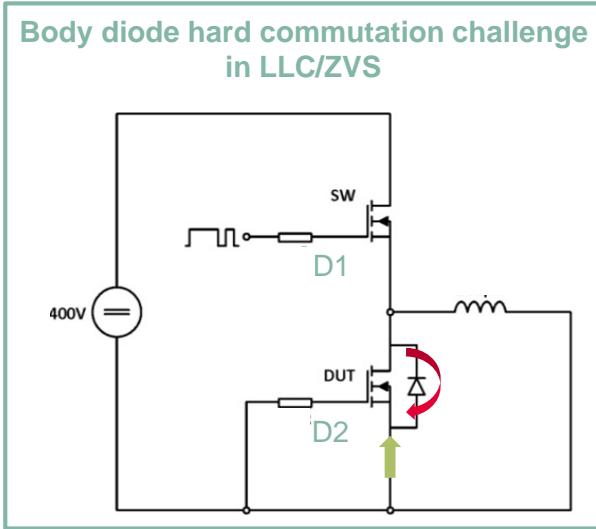
950 V CoolMOS™ P7 SJ MOSFETs product portfolio

950 V CoolMOS™ P7 SJ MOSFETs

		Industrial grade			
HBM class	R _{DS(on)} [mΩ]	TO-220 FullPAK	TO-251 IPAK LL	TO-252 DPAK	SOT-223
1C (>1 kV)	3700		IPU95R3K7P7		IPN95R3K7P7
2 (>2 kV)	2000		IPU95R2K0P7	IPD95R2K0P7	IPN95R2K0P7
	1200	IPA95R1K2P7	IPU95R1K2P7	IPD95R1K2P7	IPN95R1K2P7
	750	IPA95R750P7	IPU95R750P7	IPD95R750P7	
	450	IPA95R450P7	IPU95R450P7	IPD95R450P7	



CoolMOS™ CFD7/PFD7 family offers excellent hard commutation ruggedness thanks to outstanding body diode parameters



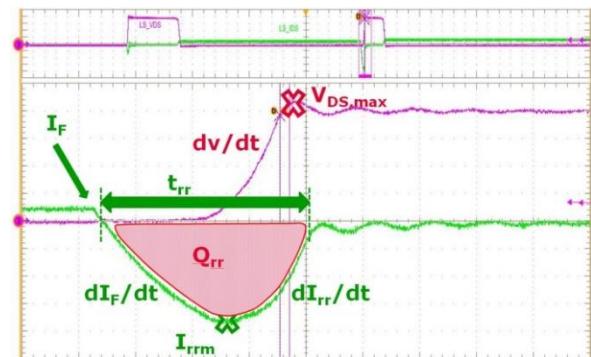
Hard commutation in ZVS/LLC ...

- Inductor drives reverse current through the body diode of D2 (free wheeling)
- As D1 is switched on again, high-side current leads to commutation of the low-side body diode
- High di/dt and voltage overshoot significantly stress D2
- Stress leading up to destruction in repeated hard commutation

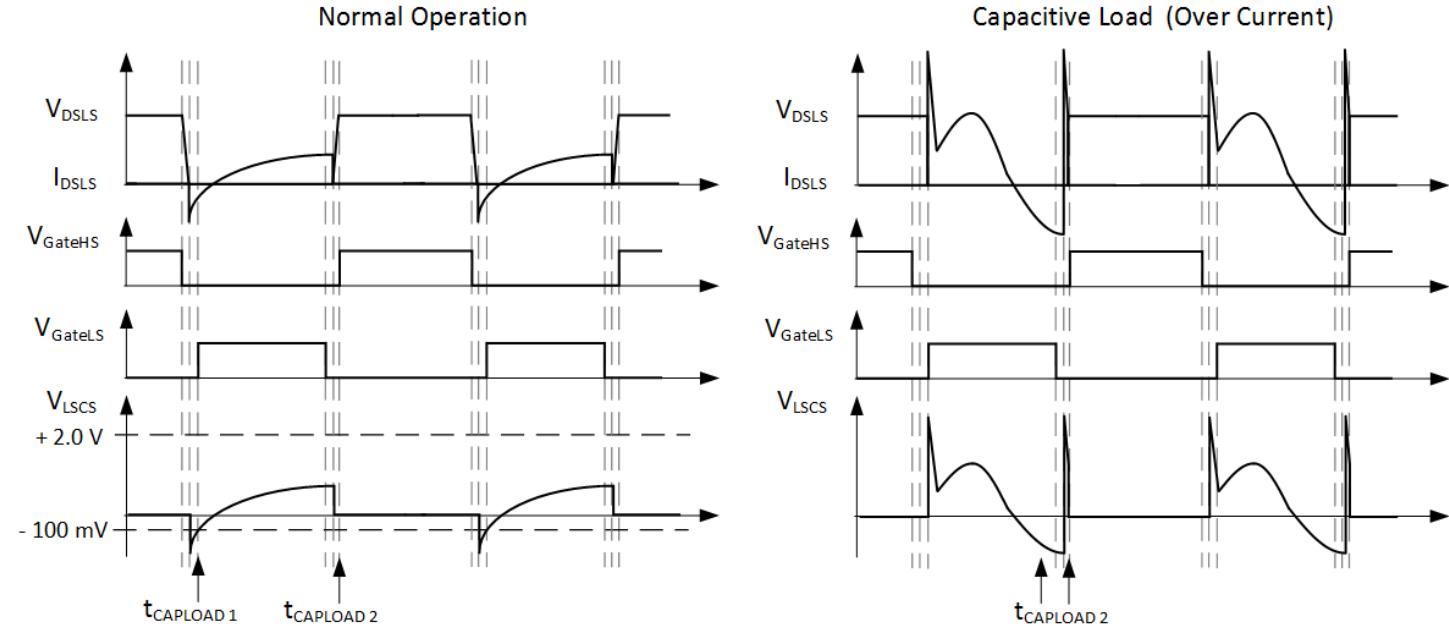
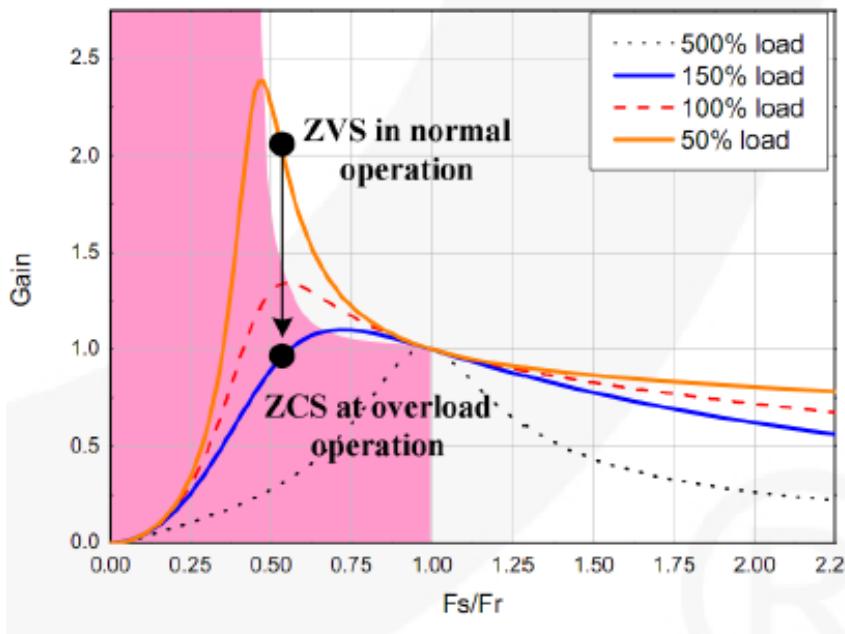
... requires fast body diode (Q_{rr} , t_{rr})

Fast body diode

- Reduces stress on device while the body diode is not fully recovered
- Provides an extra safety margin for repetitive hard commutation and reduces design-in effort



Hard commutation in LLC topology



Resonant converters work in capacitive mode when their switching frequency falls below a critical value that depends on the loading conditions and the input-to-output voltage ratio.

Difference of the internal body diode from the CoolMos family CoolMos 600V P7 and PFD7



IPD60R600P7



MOSFET

600V CoolMOS™ P7 Power Device

The CoolMOS™ 7th generation platform is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The 600V CoolMOS™ P7 series is the successor to the CoolMOS™ P6 series. It combines the benefits of a fast switching SJ MOSFET with excellent ease of use, e.g. very low ringing tendency, outstanding robustness of body diode against hard commutation and excellent ESD capability. Furthermore, extremely low switching and conduction losses make switching applications even more efficient, more compact and much cooler.

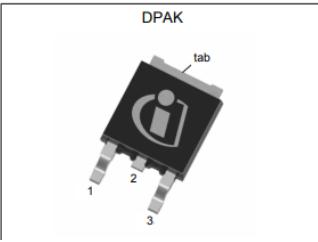


Table 1 Key Performance Parameters

Parameter	Value	Unit
$V_{DS} @ T_{j,max}$	650	V
$R_{DS(on),max}$	600	mΩ
$Q_{g,typ}$	9	nC
$I_D,pulse$	16	A
$E_{oss} @ 400V$	1.1	μJ
Body diode di_F/dt	900	A/μs

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}	-	0.9	-	V	$V_{GS}=0V, I_F=1.7A, T_j=25^\circ C$
Reverse recovery time	t_{rr}	-	160	-	ns	$V_R=400V, I_F=1A, di_F/dt=100A/\mu s$; see table 8
Reverse recovery charge	Q_{rr}	-	0.71	-	μC	$V_R=400V, I_F=1A, di_F/dt=100A/\mu s$; see table 8
Peak reverse recovery current	I_{rrm}	-	9.9	-	A	$V_R=400V, I_F=1A, di_F/dt=100A/\mu s$; see table 8

IPD60R600PFD7S



MOSFET

600V CoolMOS™ PFD7 SJ Power Device

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The latest CoolMOS™ PFD7 is an optimized platform tailored to target cost sensitive applications in consumer markets such as charger, adapter, motor drive, lighting, etc. The new series provides all the benefits of a fast switching Superjunction MOSFET, combined with an excellent price/performance ratio and state-of-the-art ease-of-use level. The technology meets highest efficiency standards and supports high power density, enabling customers going towards very slim designs.

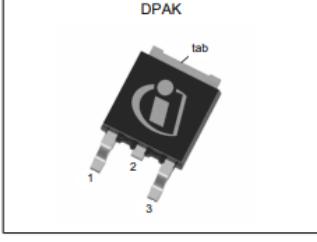


Table 1 Key Performance Parameters

Parameter	Value	Unit
$V_{DS} @ T_{j,max}$	650	V
$R_{DS(on),max}$	600	mΩ
$Q_{g,typ}$	8.5	nC
$I_D,pulse$	14	A
$E_{oss} @ 400V$	1.1	μJ
Body diode di_F/dt	1300	A/μs
ESD Class (HBM)	2	-

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}	-	1.0	-	V	$V_{GS}=0V, I_F=1.7A, T_j=25^\circ C$
Reverse recovery time	t_{rr}	-	47	71	ns	$V_R=400V, I_F=1.7A, di_F/dt=100A/\mu s$; see table 8
Reverse recovery charge	Q_{rr}	-	0.10	0.20	μC	$V_R=400V, I_F=1.7A, di_F/dt=100A/\mu s$; see table 8
Peak reverse recovery current	I_{rrm}	-	3.8	-	A	$V_R=400V, I_F=1.7A, di_F/dt=100A/\mu s$; see table 8

Difference of the internal body diode from the CoolMos family CoolMos 950V P7 and PFD7



IPD95R450P7



IPD95R450PFD7



MOSFET

950V CoolMOS™ P7 SJ Power Device

The latest 950V CoolMOS™ P7 series sets a new benchmark in 950V super junction technologies and combines best-in-class performance with state of the art ease-of-use, resulting from Infineon's over 18 years pioneering super junction technology innovation.

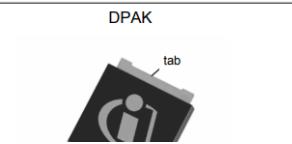


Table 1 Key Performance Parameters

Parameter	Value	Unit
V _{DS} @ T _j =25°C	950	V
R _{DS(on),max}	0.45	Ω
Q _{g,typ}	35	nC
I _D	14	A
E _{oss} @ 500V	2.9	μJ
V _{GS(th),typ}	3	V
ESD class (HBM)	2	-

950V CoolMOS™ P7 SJ Power Device

IPD95R450P7



Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =7.2A, T _j =25°C
Reverse recovery time	t _{rr}	-	707	-	ns	V _R =400V, I _F =3.6A, dI _F /dt=50A/μs; see table 8
Reverse recovery charge	Q _{rr}	-	6	-	μC	V _R =400V, I _F =3.6A, dI _F /dt=50A/μs; see table 8
Peak reverse recovery current	I _{rrm}	-	16	-	A	V _R =400V, I _F =3.6A, dI _F /dt=50A/μs; see table 8

MOSFET

950V CoolMOS™ PFD7 SJ Power Device

The latest 950V CoolMOS™ PFD7 series sets a new benchmark in the super junction (SJ) technologies. This technology is designed to address Lighting and Industrial SMPS applications by combining best-in-class performance with state-of-the-art ease of use. Compared to the CoolMOS™ P7 families, the PFD7 offers an integrated ultra-fast body diode enabling usage in resonant topologies with markets lowest reverse recovery charge (Q_{rr}).

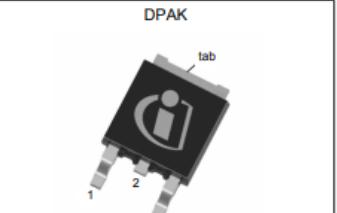


Table 1 Key Performance Parameters

Parameter	Value	Unit
V _{DS} @ T _j = 25 °C	950	V
R _{DS(on),max}	450	mΩ
Q _{g,typ}	43	nC
I _D	13.3	A
E _{oss} @ 500V	3.0	μJ
Body diode dI _F /dt	1300	A/μs
Q _{oss} @ 500V	0.1	μC

950V CoolMOS™ PFD7 SJ Power Device

IPD95R450PFD7



Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V _{SD}	-	1.1	-	V	V _{GS} =0V, I _F =7.2A, T _j =25°C
Reverse recovery time	t _{rr}	-	149	-	ns	V _R =400V, I _F =7.2A, dI _F /dt=100A/μs; see table 8
Reverse recovery charge	Q _{rr}	-	0.72	-	μC	V _R =400V, I _F =7.2A, dI _F /dt=100A/μs; see table 8
Peak reverse recovery current	I _{rrm}	-	9.3	-	A	V _R =400V, I _F =7.2A, dI _F /dt=100A/μs; see table 8

Differences of the maximum ratings mosfet ruggedness dv/dt

950V CoolMOS™ P7 SJ Power Device
IPD95R450P7



1 Maximum ratings

at $T_j = 25^\circ\text{C}$, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current ¹⁾	I_D	-	-	14 8.6	A	$T_c=25^\circ\text{C}$ $T_c=100^\circ\text{C}$
Pulsed drain current ²⁾	$I_{D,pulse}$	-	-	43	A	$T_c=25^\circ\text{C}$
Avalanche energy, single pulse	E_{AS}	-	-	29	mJ	$I_0=1.8\text{A}; V_{DD}=50\text{V}$; see table 10
Avalanche energy, repetitive	E_{AR}	-	-	0.36	mJ	$I_0=1.8\text{A}; V_{DD}=50\text{V}$; see table 10
Application (Flyback) relevant avalanche current, single pulse ³⁾	I_{AS}	-	7.0	-	A	measured with standard leakage inductance of transformer of 10μH
MOSFET dv/dt ruggedness	dv/dt	-	-	100	V/ns	$V_{DS}=0...400\text{V}$
Gate source voltage (static)	V_{GS}	-20	-	20	V	static;
Gate source voltage (dynamic)	V_{GS}	-30	-	30	V	AC ($f>1\text{ Hz}$)
Power dissipation	P_{tot}	-	-	104	W	$T_c=25^\circ\text{C}$
Storage temperature	T_{stg}	-55	-	150	°C	-
Operating junction temperature	T_j	-55	-	150	°C	-
Mounting torque	-	-	-	-	Ncm	-
Continuous diode forward current	I_s	-	-	9.6	A	$T_c=25^\circ\text{C}$
Diode pulse current ²⁾	$I_{S,pulse}$	-	-	43	A	$T_c=25^\circ\text{C}$
Reverse diode dv/dt ⁴⁾	dv/dt	-	-	1	V/ns	$V_{DS}=0...400\text{V}, I_{SD}<=3.6\text{A}, T_j=25^\circ\text{C}$ see table 8
Maximum diode commutation speed	di_f/dt	-	-	50	A/μs	$V_{DS}=0...400\text{V}, I_{SD}<=3.6\text{A}, T_j=25^\circ\text{C}$ see table 8
Insulation withstand voltage	V_{iso}	-	-	n.a.	V	$V_{rms}, T_c=25^\circ\text{C}, t=1\text{min}$

950V CoolMOS™ PFD7 SJ Power Device
IPD95R450PFD7



1 Maximum ratings

at $T_j = 25^\circ\text{C}$, unless otherwise specified

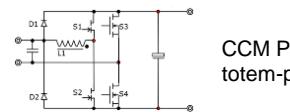
Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current ¹⁾	I_D	-	-	13.3 8.4	A	$T_c=25^\circ\text{C}$ $T_c=100^\circ\text{C}$
Pulsed drain current ²⁾	$I_{D,pulse}$	-	-	43	A	$T_c=25^\circ\text{C}$
Avalanche energy, single pulse	E_{AS}	-	-	29	mJ	$I_0=1.8\text{A}; V_{DD}=50\text{V}$; see table 10
Avalanche energy, repetitive	E_{AR}	-	-	0.22	mJ	$I_0=1.8\text{A}; V_{DD}=50\text{V}$; see table 10
Avalanche current, single pulse	I_{AS}	-	-	1.8	A	-
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	$V_{DS}=0...400\text{V}$
Gate source voltage (static)	V_{GS}	-20	-	20	V	static;
Gate source voltage (dynamic)	V_{GS}	-30	-	30	V	AC ($f>1\text{ Hz}$)
Power dissipation	P_{tot}	-	-	104	W	$T_c=25^\circ\text{C}$
Storage temperature	T_{stg}	-55	-	150	°C	-
Operating junction temperature	T_j	-55	-	150	°C	-
Mounting torque	-	-	-	-	Ncm	-
Continuous diode forward current	I_s	-	-	9	A	$T_c=25^\circ\text{C}$
Diode pulse current ²⁾	$I_{S,pulse}$	-	-	43	A	$T_c=25^\circ\text{C}$
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	$V_{DS}=0...400\text{V}, I_{SD}<=9\text{A}, T_j=25^\circ\text{C}$ see table 8
Maximum diode commutation speed	di_f/dt	-	-	1300	A/μs	$V_{DS}=0...400\text{V}, I_{SD}<=9\text{A}, T_j=25^\circ\text{C}$ see table 8
Insulation withstand voltage	V_{iso}	-	-	n.a.	V	$V_{rms}, T_c=25^\circ\text{C}, t=1\text{min}$

600 V/650 V CoolMOS™, CoolSiC™, and CoolGaN™ FOMs analysis

DEVICE	$V_{(BR)DSS}$ [V]	$R_{DS(on)} * Q_{rr}$ [$m\Omega * \mu C$]	$R_{DS(on)} * E_{oss}$ [$m\Omega * \mu J$]	$R_{DS(on)} * Q_g$ [$m\Omega * nC$]	$R_{DS(on)} * Q_{oss}$ [$m\Omega * \mu C$]
CoolMOS™ 7	600	100%	100%	100%	100%
CoolMOS™ 7– fast diode	600	10%	104%	108%	104%
CoolGaN™ Gen 1	600	0%	84%	6%	13%
CoolSiC™ Gen 1	650	2%	133%	41%	21%

Allows WBG usage in topologies with repetitive hard commutation (e.g., CCM totem-pole PFC) → BOM savings for highest efficiency

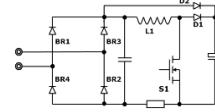


CCM PFC
totem-pole



SiC/GaN in
servers, OBC

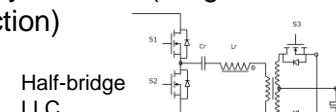
Minimum switching losses in hard-switching topologies (e.g., classic boost PFC) → higher efficiency with GaN



Classic Boost
PFC

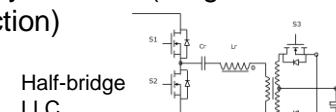
Si for best cost – performance ratio

Reduced driving losses especially at light-load conditions. Allows WBG to reach higher efficiency at increased frequency → power density increase (weight & size reduction)



Half-bridge
LLC

high power density
e.g., GaN for chargers



Enables better soft-switching (e.g. half-bridge LLC), where WBG leads to higher efficiency combined with high frequencies



SiC and GaN
e.g., in telecom

Both SiC and Gan allow an easier way than Si to top efficiency

The 3 products have similar behaviour in hard-switching topologies like classic PFC

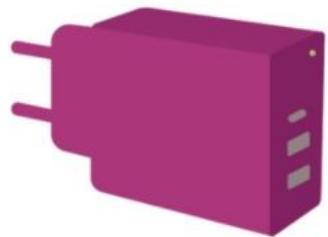
For power density, SiC is better than Si but the champion is GaN

SiC and GaN are both better than Si to reach both high efficiency and high density

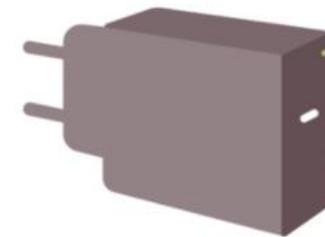
While doubling power density,
CoolGaN™ is positioned to be the future of mobile charging



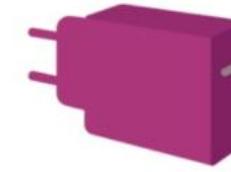
What higher power density means to customers



More power, same size



Current adapter



Same power, smaller size

System savings

3x

switching
frequency

> 30%

energy
savings

20%

lower
System Cost

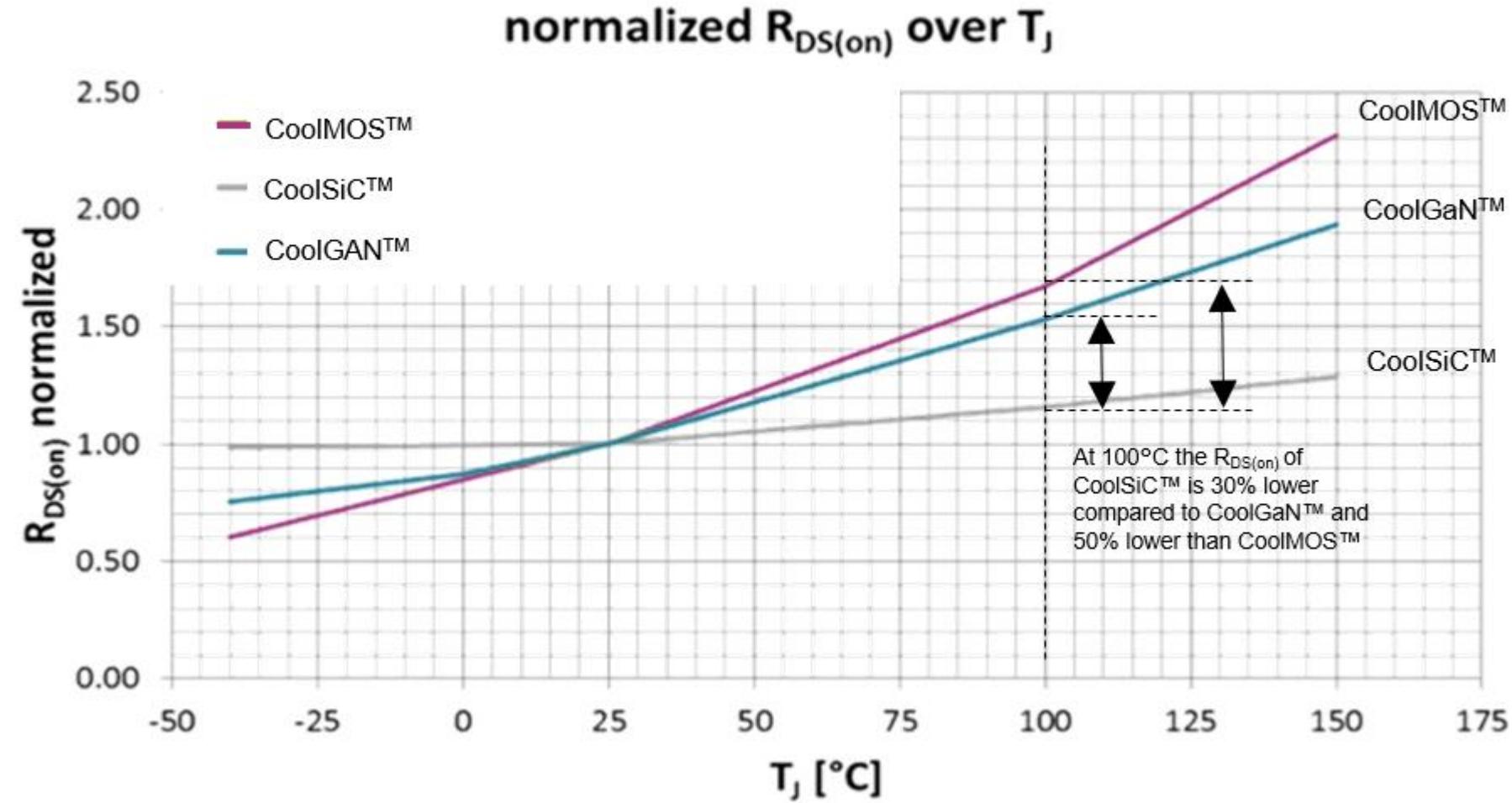
50%

higher power
density

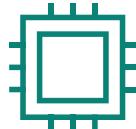
2x

less
Size & weight

Comparison: $R_{DS(on)} = f(T_J)$



Infineon completes acquisition of GaN Systems, becoming a leading GaN Power House



Addressing fast-growth applications with **highly complementary strengths** in IP, application understanding, customer access and project pipeline



Significant **roadmap acceleration** through unmatched R&D resources and application expertise



Leadership in Power Systems through mastery of all relevant power technologies – Si, SiC, GaN

GaN brings a significant value proposition in many applications



On-board Charger



On-board charger: increasing power density from today's 2kW/l to 10kW/l with GaN



HP SMPS



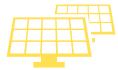
HP-SMPS for server: GaN is enabling highest power density and efficiency, to enable Accelerated- and AI computing at lowest TCO



Charger & Adapter



High-density charger & adapter: GaN enables smallest form factors for multiport chargers & adapters



Renewables



ESS DCDC converter: highest efficiency and space reduction with GaN vs Si implementation



Motor Control



GaN increases of overall system efficiency by reduction of motor-current ripple and switching losses



48V DCDC



48V to ~7V/1V conversion: with GaN brings smaller form factors to Accelerated- and AI computing as well as Telecom brick converters

By extending our leading GaN portfolio in the segments of 100V and 650V we will provide you even more freedom to design



		GaN transistors							Int. Power Stages			Gate Driver ICs	
Voltage	R _{dson} (Max @ 25C)	Die	GaNPX® Top & Bottom cooled	PQFN 3x5	PDFN 5x6	PDFN 8x8	TOLL	DSO Top & Bottom cooled	QFN 8x8 Half-Bridge	LGA 6x8 Half-Bridge	QFN 8x8 1-channel	Isolation Functional	Isolation Functional
600 V and 650 V	650												
	570												
	340												
	260-285												
	190-195												
	130												
	110												
	90												
	63-70		AEC										
	42												
	32		AEC										
100 V	13	AEC											
	22												
	10												
	3.3												

- Bringing the companies together provides a larger portfolio with more resources
- In the cases of product overlap, the products operate similarly, and customers have validated them as alternate sources for each other

Infineon Former GaN Systems

AEC = option available for Automotive use

IGLR60R190D1 600V CoolGaN™ enhancement-mode Power Transistor

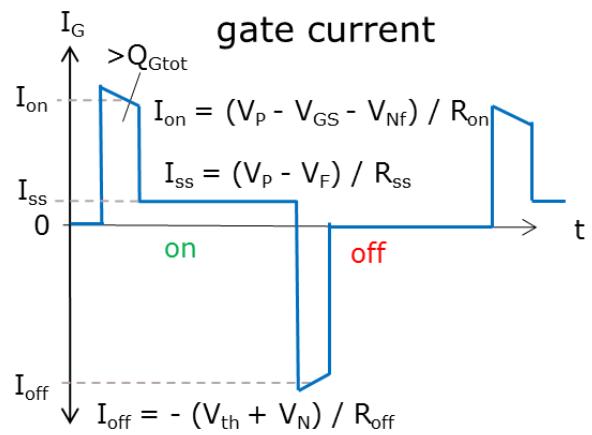


Figure 11 Typ. gate characteristics forward

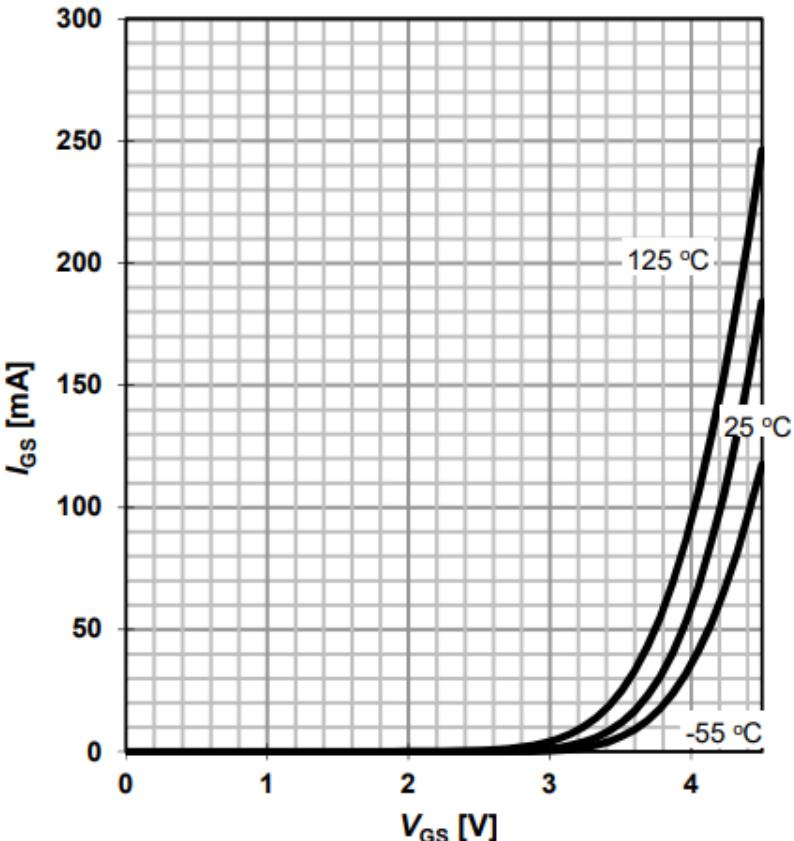
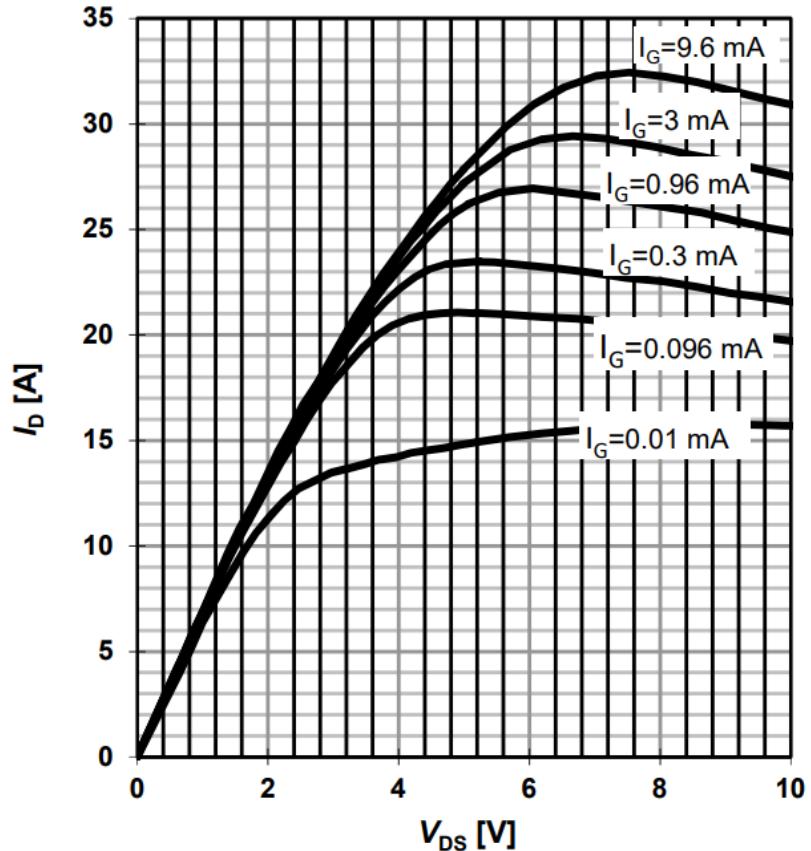


Figure 7 Typ. output characteristics



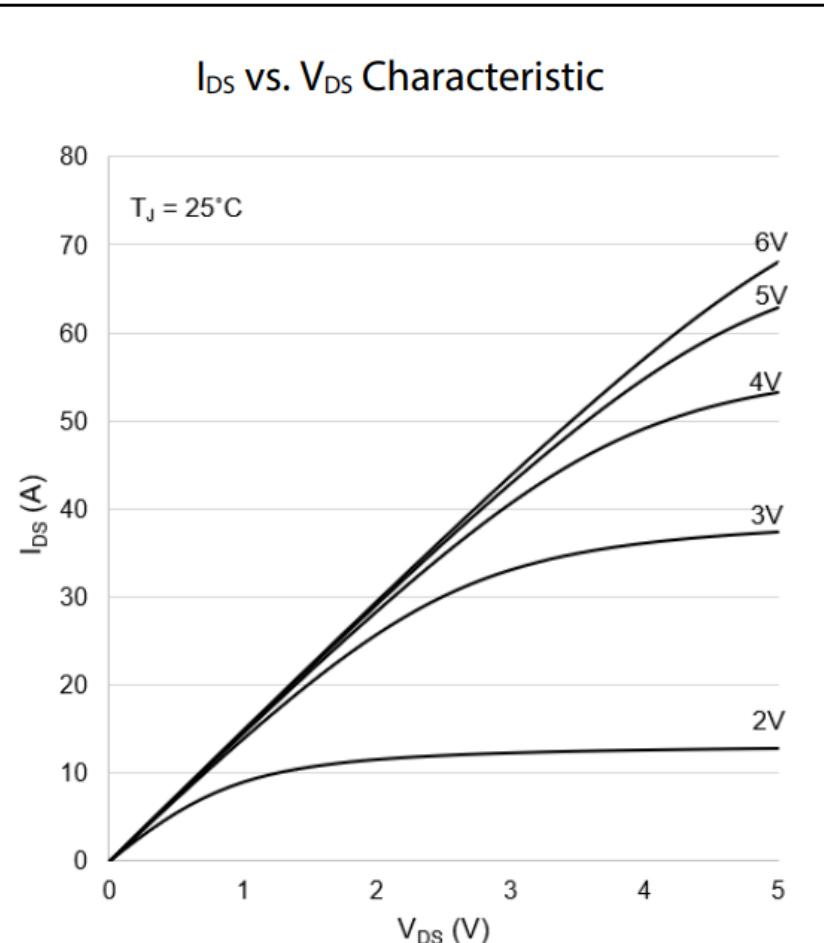


Figure 1: Typical I_{DS} vs. V_{DS} @ T_J = 25 °C

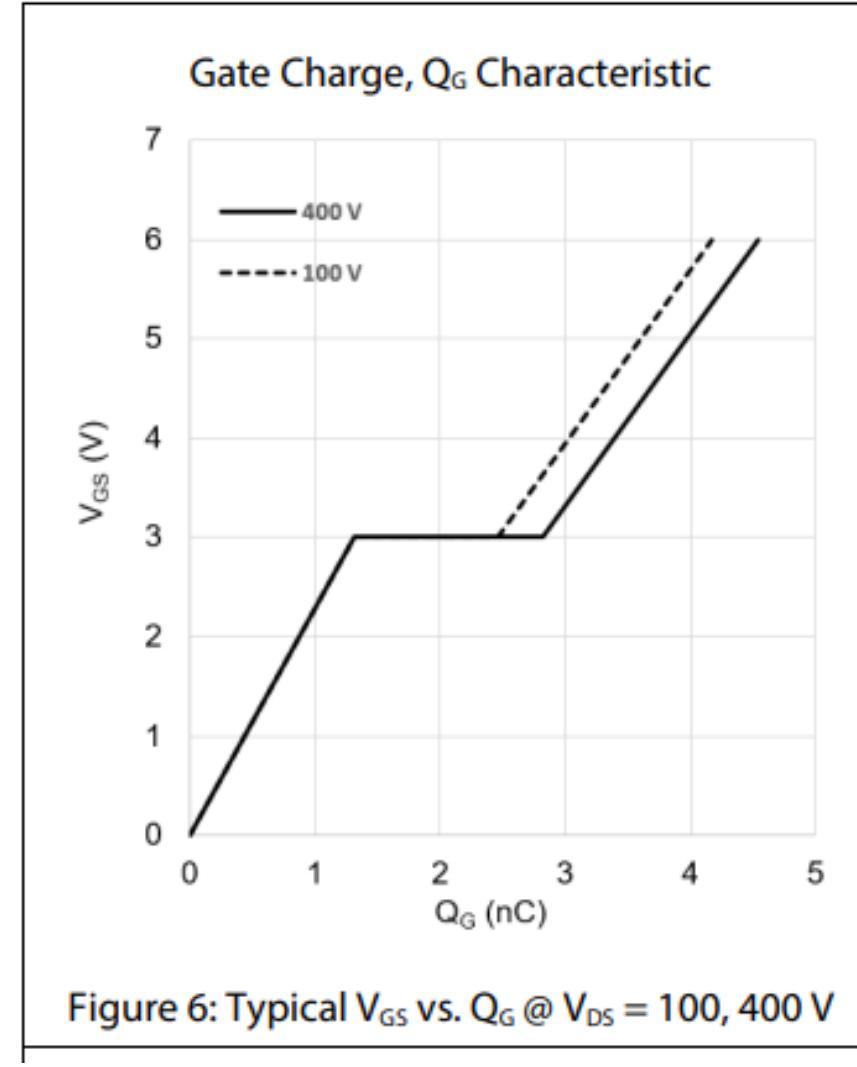


Figure 6: Typical V_{GS} vs. Q_G @ V_{DS} = 100, 400 V

Comparison of the source connection CoolGaN versus CoolMos

IGLR60R260D1



IGLR60R260D1

600V CoolGaN™ enhancement-mode Power Transistor

Features

- Enhancement mode transistor – Normally OFF switch
- Ultra fast switching
- No reverse-recovery charge
- Capable of reverse conduction
- Low gate charge, low output charge
- Superior commutation ruggedness
- Qualified for industrial applications according to JEDEC Standards (JESD47 and JESD22)

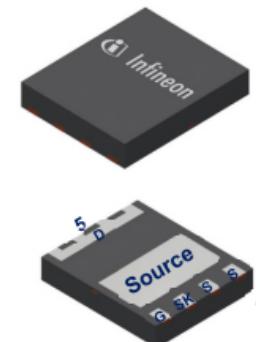
Benefits

- Improves system efficiency
- Improves power density
- Enables higher operating frequency
- System cost reduction savings
- Reduces EMI

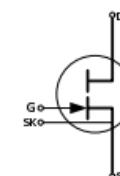
Applications

Industrial and consumer SMPS based on the half-bridge topology (half-bridge topologies for hard and soft switching such as Totem pole PFC, high frequency LLC, Hybrid Flyback and ACF).

For other applications: review CoolGaN™ reliability white paper and contact Infineon regional support



Gate	4
Drain	5
Kelvin Source	3
Source	1,2



IPD70R1K4P7S

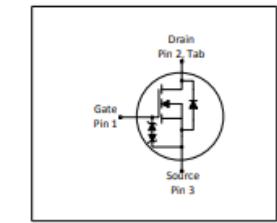
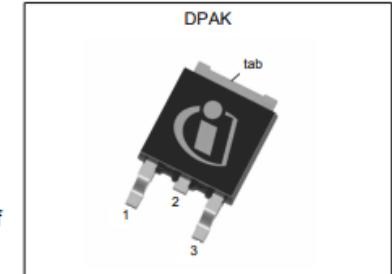
MOSFET

700V CoolMOS™ P7 Power Transistor

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

The latest CoolMOS™ P7 is an optimized platform tailored to target cost sensitive applications in consumer markets such as charger, adapter, lighting, TV, etc.

The new series provides all the benefits of a fast switching Superjunction MOSFET, combined with an excellent price/performance ratio and state of the art ease-of-use level. The technology meets highest efficiency standards and supports high power density, enabling customers going towards very slim designs.



Features

- Extremely low losses due to very low FOM $R_{DS(on)} \cdot Q_g$ and $R_{DS(on)} \cdot E_{oss}$
- Excellent thermal behavior
- Integrated ESD protection diode
- Low switching losses (E_{oss})
- Product validation acc. JEDEC Standard

Benefits

- Cost competitive technology
- Lower temperature
- High ESD ruggedness
- Enables efficiency gains at higher switching frequencies
- Enables high power density designs and small form factors

Potential applications

Recommended for Flyback topologies for example used in Chargers, Adapters, Lighting Applications, etc.

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



XDP™ digital power XDPS2222: PFC + hybrid flyback combo IC

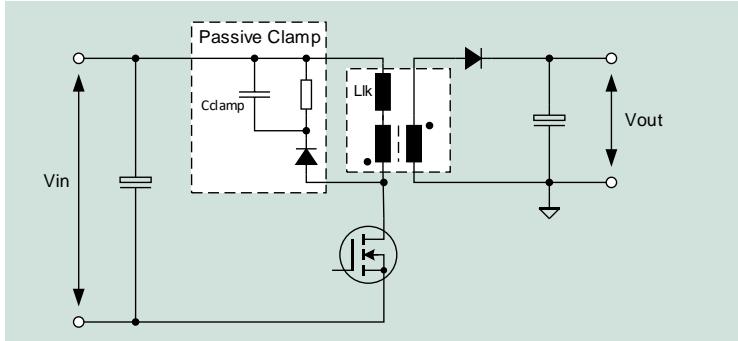
Key features at a glance



Typical application	Key features
<p>Inherent HFB topology advantages</p> <ul style="list-style-type: none">Low voltage stress on primary and secondary switchesSmall transformer by resonant energy transfer	<ul style="list-style-type: none">600 V high voltage start-up cell for fast VCC chargingNovel ZVS hybrid flyback topology (asymmetrical half-bridge) for ultra-high system efficiencyHFB peak current control for robust and fast controlHFB ZVS operation of high-side and low-side switch (with ZVS pulse insertion in DCM)PFC QRM multimode operation for improved efficiencyHarmonized PFC and hybrid flyback controlBurst mode operation control for lowest stand-by powerSupports extra wide output voltage range with MFIO switching depending on output voltageIntegrated gate drivers supporting GaN switchesConfigurability for protections and system performanceDSO-14 (150mil) package

DC-DC topology comparison

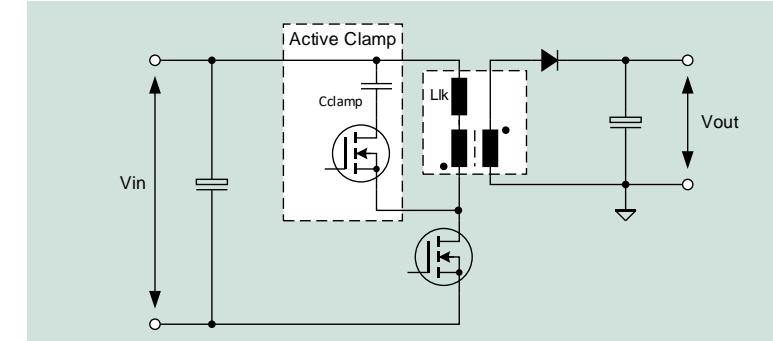
Conventional flyback with snubber



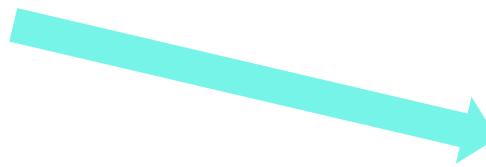
- Recycling the **leakage energy for ZVS**
- But: all energy stored in transformer



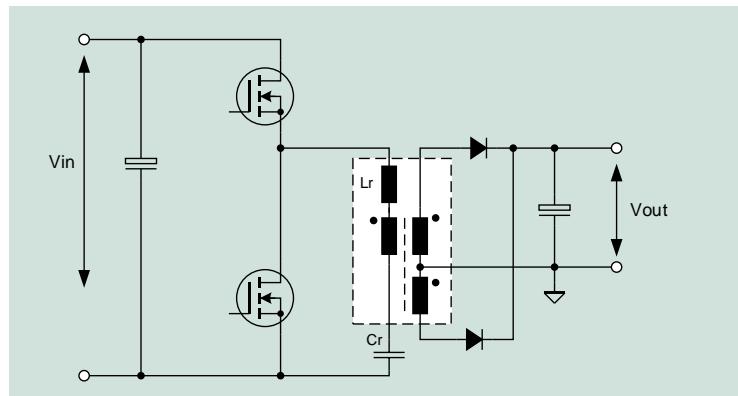
Active clamp flyback



- Using flyback principle with time separated energy storage and transmission phase

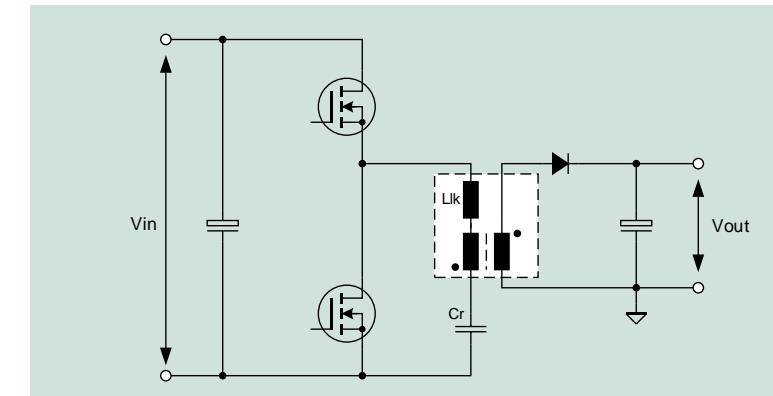


LLC (Forward resonant half-bridge)



- Using resonant energy storage for **substantial energy transmission** and ZVS

Hybrid flyback



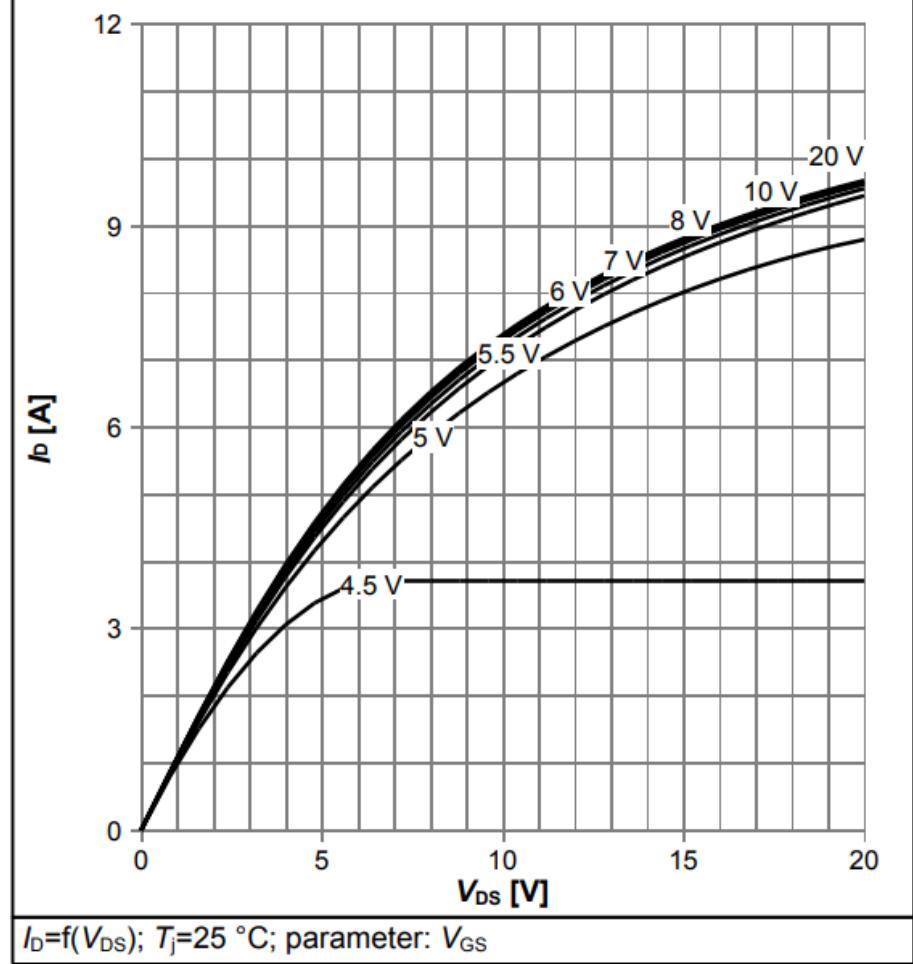
- Reduced magnetic energy for **transformer size reduction**
- Lower breakdown voltage requirement of **output rectifier**

Differences of the Gate threshold CoolMos 950V versus CoolSiC 1700V

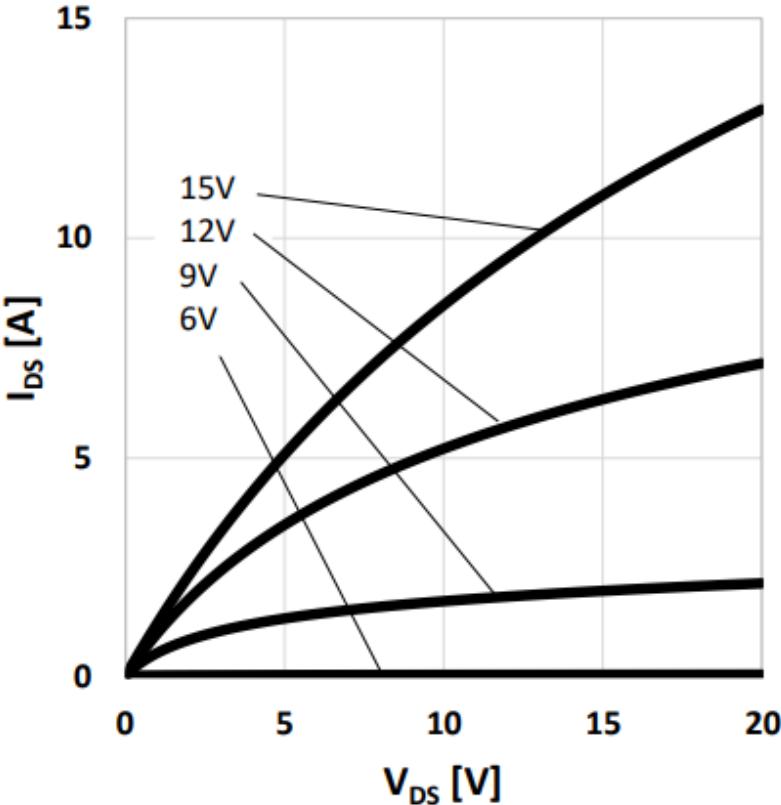


950VCoolMOS P7 SJ Power Device 1,2Ω

Diagram 5: Typ. output characteristics



CoolSiC™ 1700V SiC Trench MOSFET 1Ω



Conclusion of the required threshold voltage:

- To turn on a CoolMos, the gate voltage should be higher than 6V and for CoolSiC higher than 12V.
- The typical value of the gate voltage of 3rd and 5th generation Flyback Controller from Infineon is 10V. That means a separate driver is required to drive a CoolSiC Mosfet

figure 7 Typical output characteristic, V_{GS} as parameter

$$(I_D = f(V_{DS}), T_{vj} = 25^\circ C, t_P = 20\mu s)$$

Introduction

- › Enabled by EiceDRIVER™ 1EDNx550
- › Small form factor (SOT23 and TSNP-6)
- › Selectable UVLO
 - 12.2V & 14.9V UVLO options
- › 8A/4A sink/source
- › Industrial drives, EV and solar

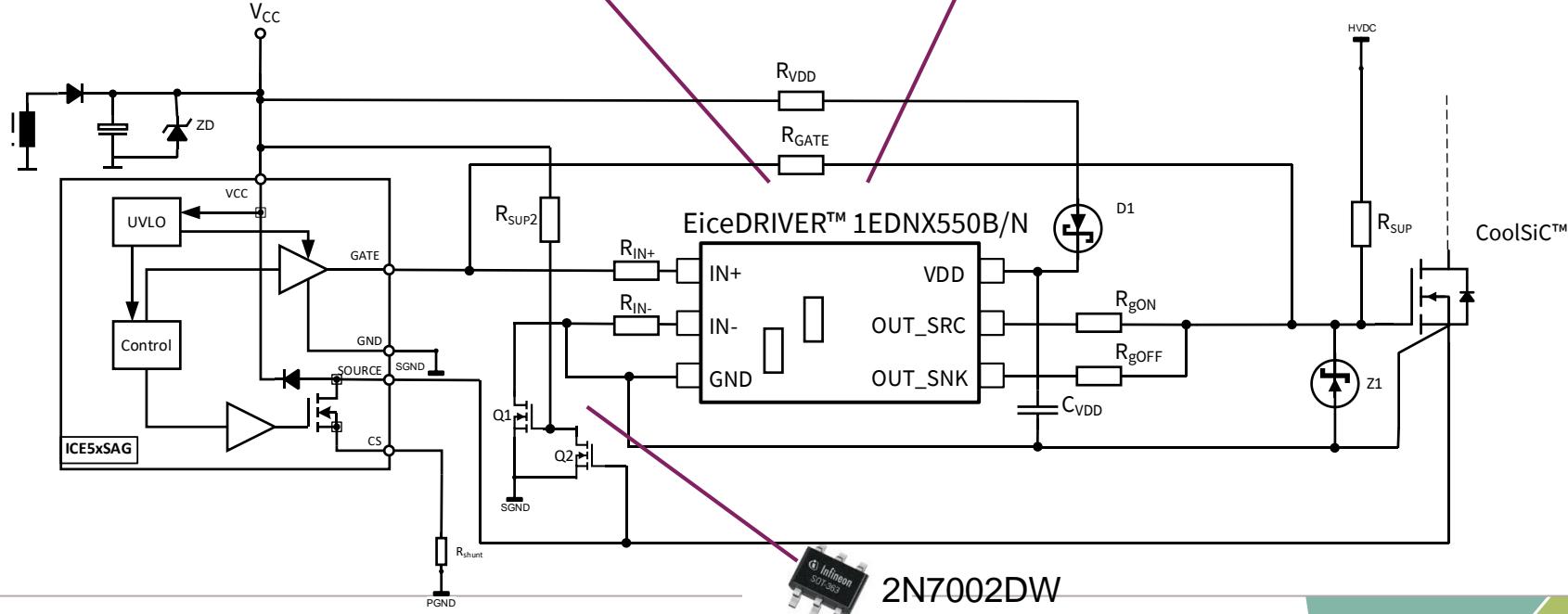


SOT23-6



TSNP-6

Simplified schematic



CoolSiC™ MOSFET 1200 V / 1700 V discrete

TO-247

$R_{DS(on)}$ [mΩ]	1200 V TO-247-3	1200 V TO-247-4
7	IMW120R007M1H	IMZA120R007M1H
14	IMW120R014M1H	IMZA120R014M1H
20	IMW120R020M1H	IMZA120R020M1H
30	IMW120R030M1H	IMZ120R030M1H
40 / 45	IMW120R040M1H / IMW120R045M1	IMZA120R040M1H / IMZ120R045M1
60	IMW120R060M1H	IMZ120R060M1H
90	IMW120R090M1H	IMZ120R090M1H
140	IMW120R140M1H	IMZ120R140M1H
220	IMW120R220M1H	IMZ120R220M1H
350	IMW120R350M1H	IMZ120R350M1H



SMD

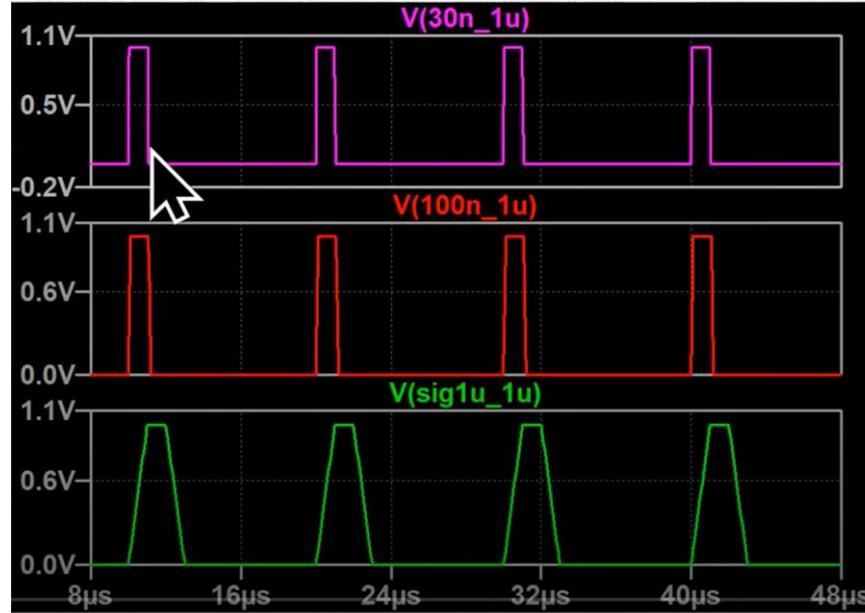
$R_{DS(on)}$ [mΩ]	1200 V D²PAK-7	$R_{DS(on)}$ [mΩ]	1700 V D²PAK-7 high creepage
30	IMBG120R030M1H	450	IMBF170R450M1
45	IMBG120R045M1H	650	IMBF170R650M1
60	IMBG120R060M1H	1000	IMBF170R1K0M1
90	IMBG120R090M1H		
140	IMBG120R140M1H		
220	IMBG120R220M1H		
350	IMBG120R350M1H		



The effect of gate turn on resistor on EM emission

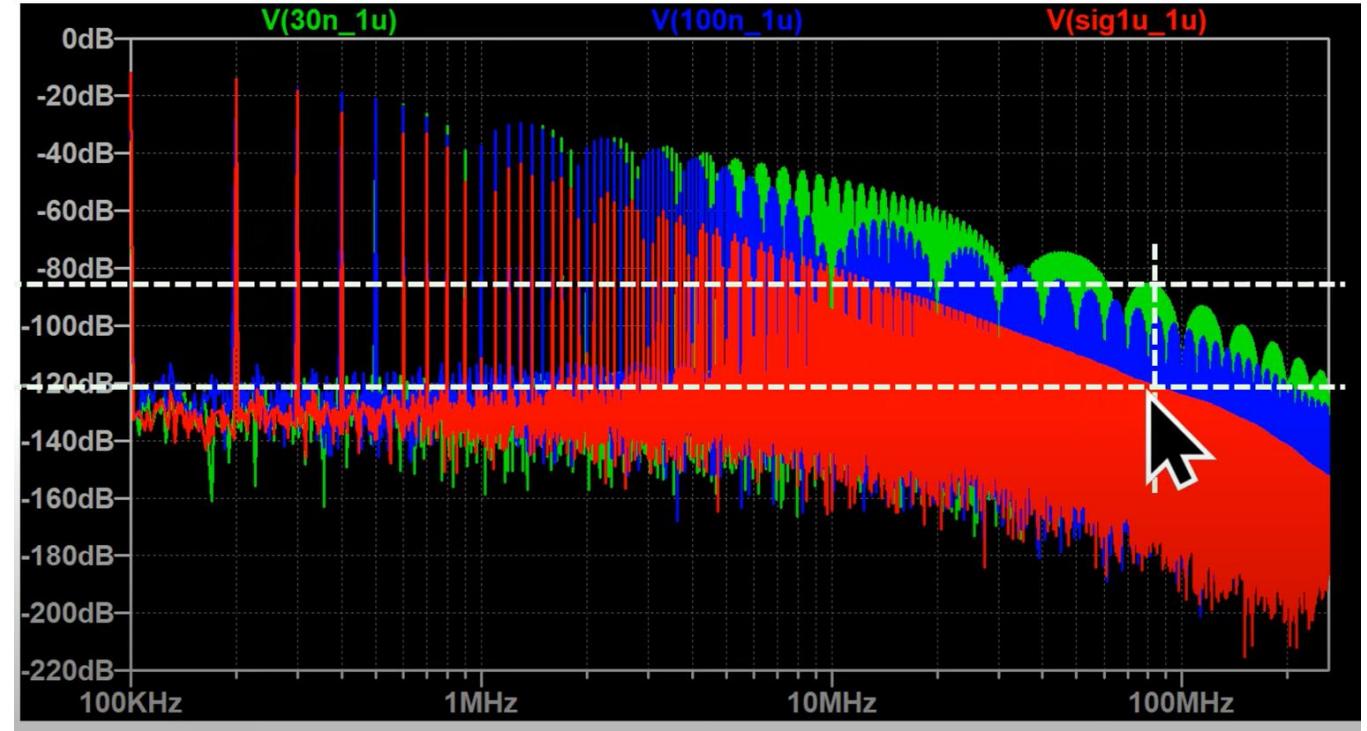
From Prof Sam Ben-Yaakov

dt/dV : Green 1 μ s/V, red = 100ns/V,
violet = 30ns/V



1. The spectrum of pulses
2. dV/dt di/dt and their effects EM emission
3. dV/dt in half a bridge – dependence on R_g
4. di/dt in half a bridge - dependence on R_g

Spectrum: Green 30ns/V, blue 100ns/V and red=1 μ s/V



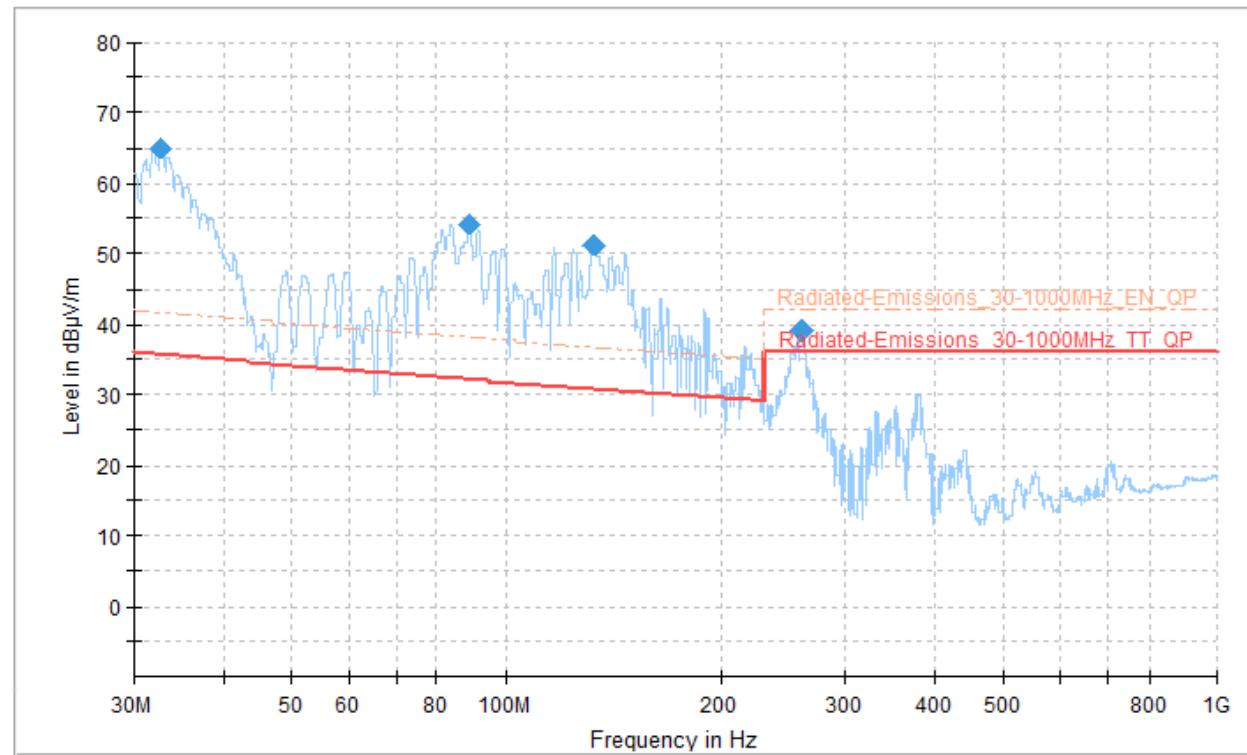
<https://www.youtube.com/watch?v=2oYYYVu4Akk&list=PLEy5cPyMzgySUYaT0AD8rziAf6q2VEhCN&index=172>

EMI requirement according to radiated emissions EN55014-1

Scan setup:

Frequencies			Receiver settings					
Start	Stop	Step	Res-BW	Detector	M- Time	Atten	Preamp	Pre-Scan Mode
30MHz	1000MHz	30kHz	120kHz	QP	1s	auto	on	Fast (TD/FFT) Repeat max hold

Final measurement:
 Detector: QP
 M-Time: 1s
 Acceptance: 6dB
 Peaks: 10



Operating mode:	5V (100mA) + 12V (1A)	
Measuring distance:	3 m	
Measuring hight:	1.4 m	
Polarisation:	Vertical + Horizontal	
Position horizontal	0° / 90° / 180° / 270°	
Powersupply	230 V	
EMI Test Receiver	Rohde&Schwarz	ESW44
Antenna:	Rohde&Schwarz	HL562e
EMC-Chamber:	Albatross M-CDC (FAR)	
Powersupply:		

Turn-ON (dV/dt)

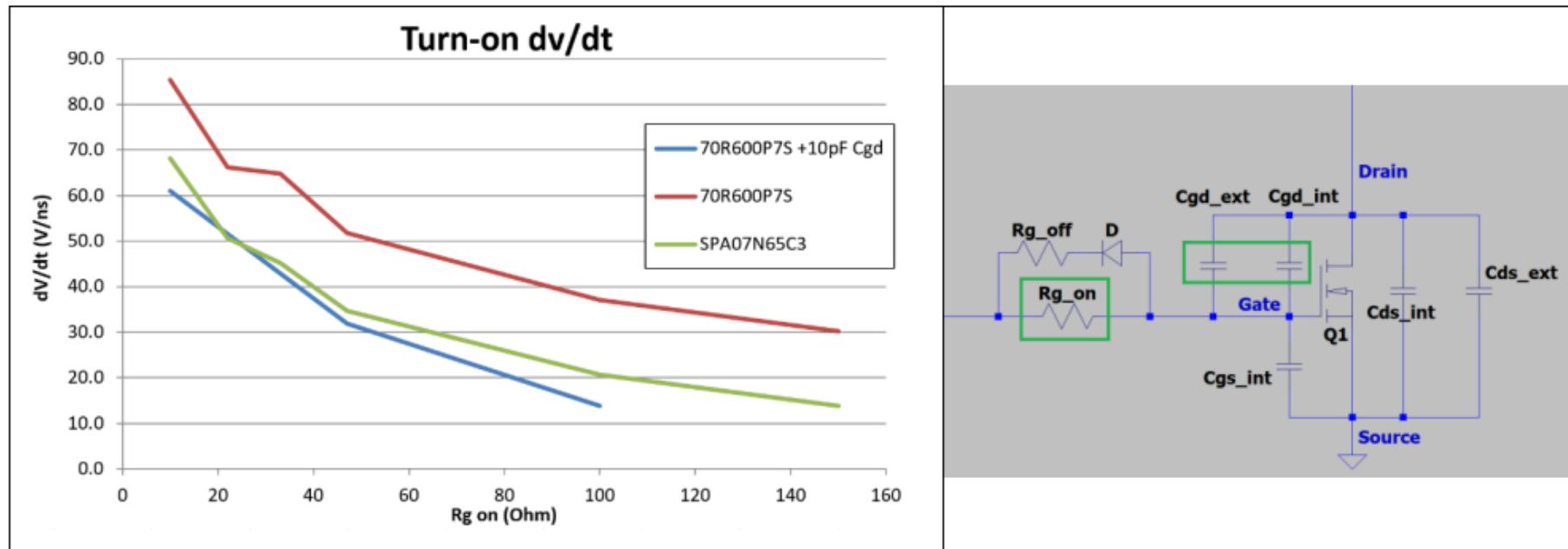


Figure 5 Effect of $R_{g\ on}$ and C_{gd} external (C_{gd_ext}) on turn-on dV/dt

The total gate resistance was adjusted from $10\ \Omega$ up to $150\ \Omega$. It can be seen that as the R_g is increased the dV/dt of the system slows down. When replacing the C3 device with an IPA70R600P7S it can be seen that the dV/dt with the same R_g external is increased. The SPA07N65C3 with an R_g external of $40\ \Omega$ has a dV/dt of 40 V/ns while the P7 would need approximately $90\ \Omega$ to achieve 40 V/ns . Adding a $10\text{ pF }1\text{ kV}$ ceramic capacitor as a C_{gd} external then makes it so the P7 device has a similar turn-on dV/dt as the C3 device, but note that this will have a negative impact on the efficiency.

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The SMPS Designer

- › Web based simulator / calculator
- › Support of quick and easy system design
- › Loss analysis of each component during different operating points
- › Eases component selection by providing all necessary information like values, component stress and voltage and current ratings
- › Option to save and load designs as well and downloadable result tables
- › [Landing page](#)

<https://www.poweresim.com/>

<http://www.how2power.com/>

Calculation tool based on EXCEL:

Gen 5 fixed frequency flyback controller

https://www.infineon.com/cms/en/product/power/ac-dc-power-conversion/ac-dc-integrated-power-stage-coolset/fixed-frequency-coolset/?tab=~%27development_tools#!designsupport

Gen 5 quasi-resonant flyback controller

https://www.infineon.com/cms/en/product/power/ac-dc-power-conversion/ac-dc-integrated-power-stage-coolset/quasi-resonant-coolset/?tab=~%27development_tools#!designsupport

PowerEsim Switch Mode Power Supply Design Tool

Overview
Support



Welcome to our SMPS Designer PowerEsim

Infineon **SMPS Designer** creates custom power supply circuits based on your requirements and proposes solutions based on our evaluation board portfolio. The environment provides you with power supply simulation and optimization capabilities that save you time and money at all stages of the switch mode power supply design process.

[Try PowerEsim now](#)

+ Easy power supply design. Select. Customize. Simulate. Export.

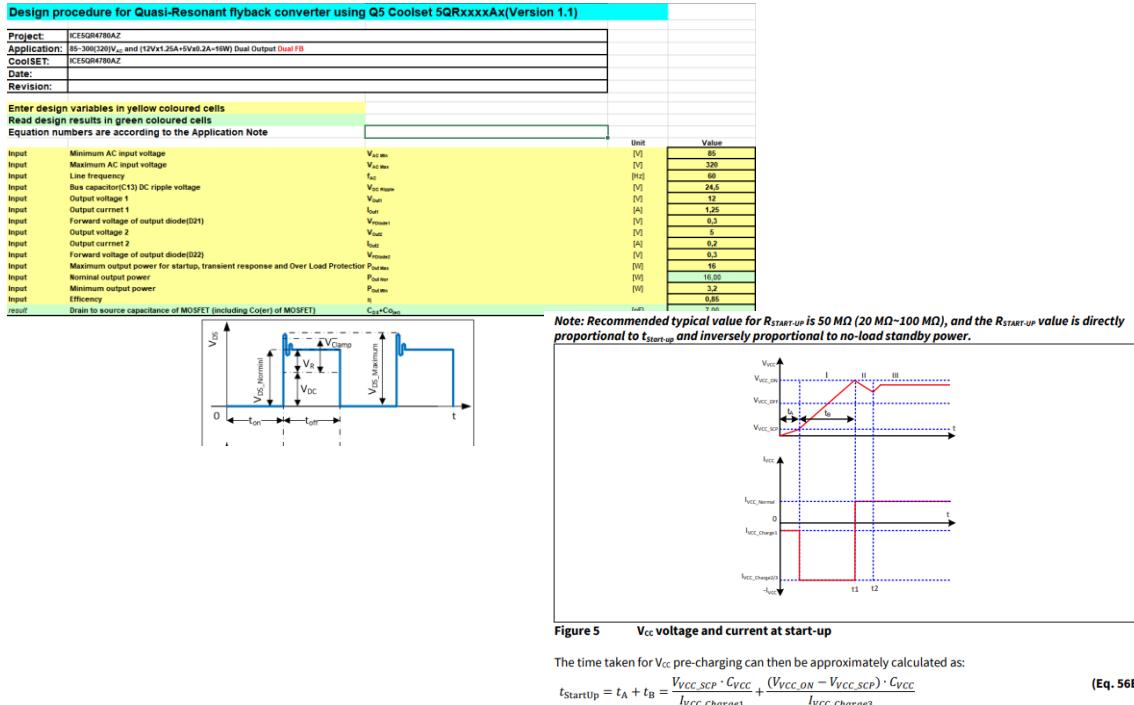
+ Our Analysis Tool Box provide a bunch of features to support your switch mode power supply development



Comparison of tools

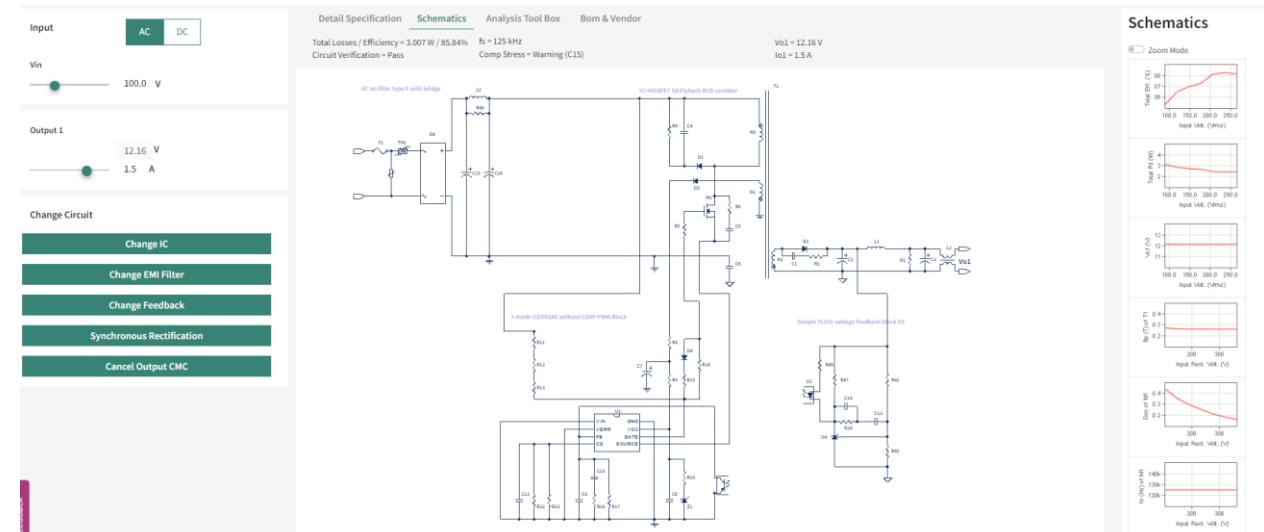
Design guide & excel tool

- Contains theory, calculation, explanations and tips
- In depth understanding of topology and IC



PowerESIM

- Online
- Very flexible transformer design



Where to get more information ?

Internet

- › <http://www.infineon.com/PWM>
- › <http://www.infineon.com/CoolSET-gen5>
 - › Datasheet
 - › Engineering report
 - › Application notes
 - › Design guide
 - › Calculation tool
 - › Product Brief



Design procedure for Quasi-Resonant flyback converter using Q5 Coolset 5QRxxxxAx (Version 1.0)

Project: ICE5QR4780AZ
Application: 9V/30W+29Vdc and 15V/1.25A+15Vdc 2A-16V Dual Output
CodeSST: ICE5QR4780AZ
Date: 2016 Oct 7
Revision: 1.0

Enter design variables in yellow coloured cells:
Read design results in green coloured cells:
Equation numbers are according to the Application Note

Input	Minimum AC input voltage	V _{AC} min
	Maximum AC input voltage	V _{AC} max
	Line frequency	V _{line}
	DC ripple voltage	V _{ripple}
	Output voltage 1	V _{out1}
	Output current 1	I _{out1}
	Forward voltage of output diode(D21)	V _{fwd}
	Output voltage 2	V _{out2}
	Output current 2	I _{out2}
	Forward voltage of output diode(D22)	V _{fwd}
	Output voltage	V _{out}
	Maximum output power for startup and transient response	P _{start}
	Normal output power	P _{out}
	Minimum output power	P _{min}
	Efficiency	η
	Drain to source capacitance of MOSFET (including C _{oss} of MOSFET)	C _{oss}

15W 12V 5V SMPS
ICE5QR4770A0G
AN-DEMO_5QR4780AZ_16W

About this document

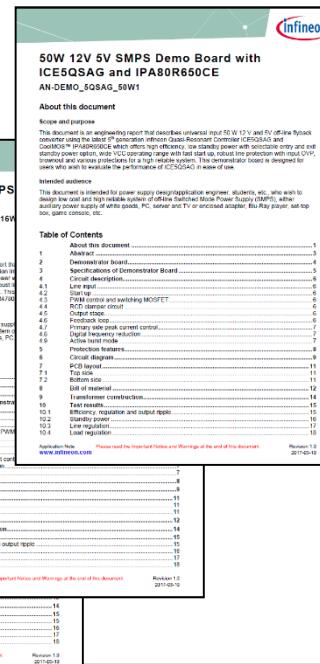
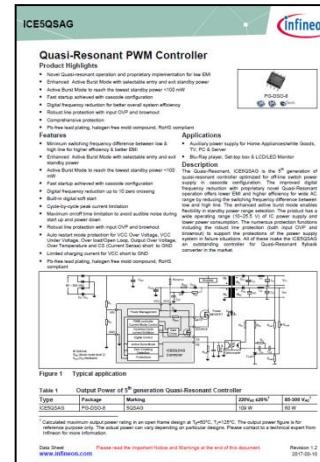
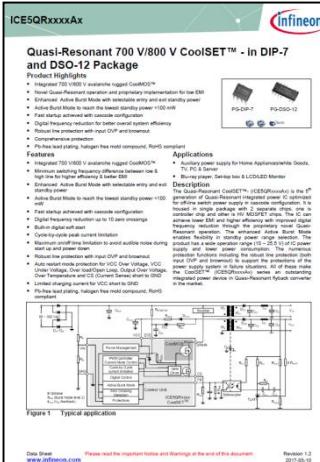
This document is an engineering note intended for power supply design engineers who want to achieve high efficiency, low cost and reliable power supplies. It provides guidelines and recommendations for prototyping a high reliable system.

Intended audience

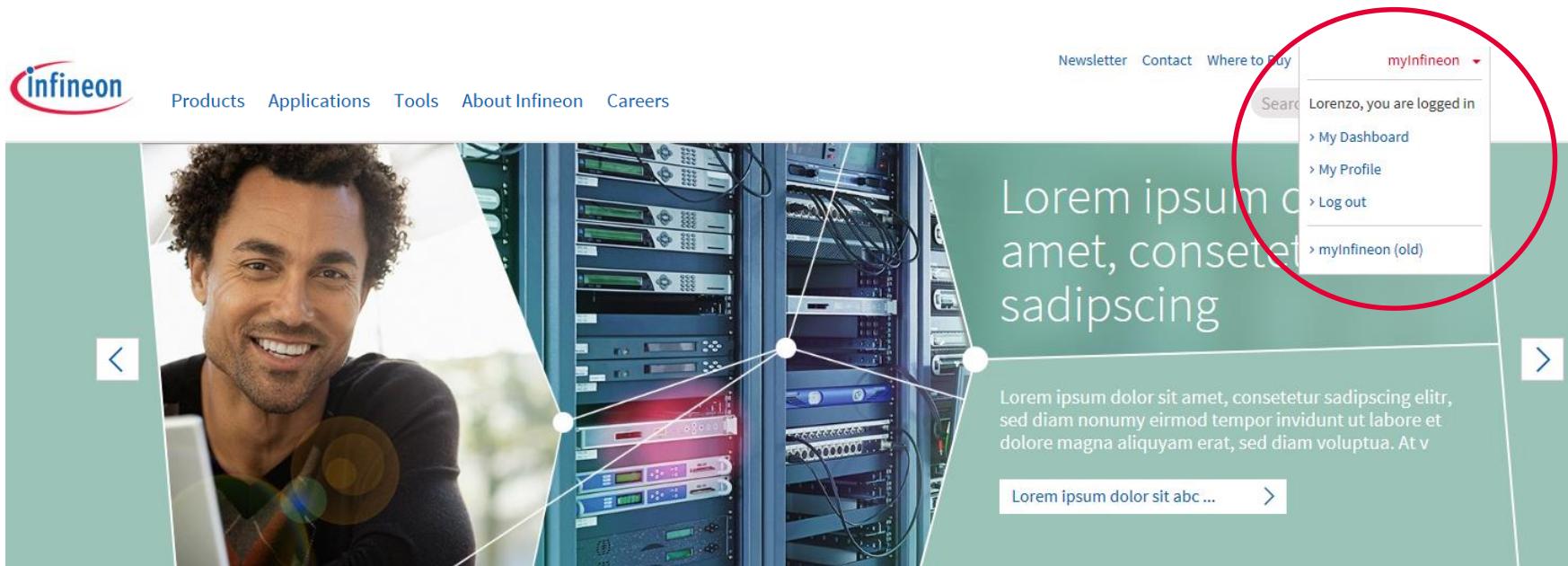
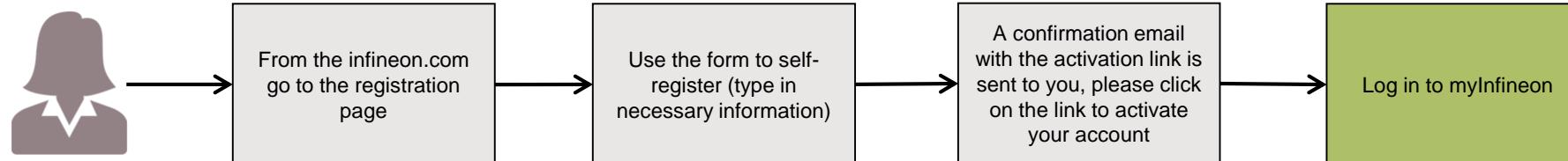
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Tailor made information via myInfineon



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Support

Online tools and services



The screenshot shows the Infineon website's header with the Infineon logo, navigation links for Products, Applications, Tools (highlighted with a red box and number 3), About Infineon, and Careers. The main content area features a large image of a city skyline at night. Overlaid on the image is the word "Lighting" and a news snippet: "New LED controller enables low-wattage luminaire designs August 26th 17:00 CEST". A "Register Now!" button is visible. The top right of the page includes a search bar, a "Newsletter" link (highlighted with a red box and number 1), a "Where to Buy" link (highlighted with a red box and number 2), language selection (English), and a login link.

- 1 **Subscribe to Newsletter**
- 2 **Where to Buy**
- 3 **Tools, Finders and Selectors**
- 4 **Support**

The screenshot shows the bottom navigation menu with categories: Products, Applications, Tools (highlighted with a red box and number 4), Support, and Technology. Below this, there are three columns of links under the "Power" category: Power Overview, Power MOSFET, IGBT, Smart Low-Side & High-Side Switches, Linear Voltage Regulator, DC-DC Converter, LED Driver | Lighting ICs, Silicon Carbide (SiC), High Power Thyristors & Diodes, Motor Control & Gate Driver, and AC-DC Supply. At the very bottom, there is a "News & Tweets" section.



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